



**THE DATASHEET OF  
AD9781BCPZ**



## FEATURES

- High dynamic range, dual DAC parts
- Low noise and intermodulation distortion
- Single carrier W-CDMA ACLR = 80 dBc at 61.44 MHz IF
- Innovative switching output stage permits usable outputs beyond Nyquist frequency
- LVDS inputs with dual-port or optional interleaved single-port operation
- Differential analog current outputs are programmable from 8.6 mA to 31.7 mA full scale
- Auxiliary 10-bit current DACs with source/sink capability for external offset nulling
- Internal 1.2 V precision reference voltage source
- Operates from 1.8 V and 3.3 V supplies
- 315 mW power dissipation
- Small footprint, RoHS compliant, 72-lead LFCSP

## APPLICATIONS

- Wireless infrastructure
- W-CDMA, CDMA2000, TD-SCDMA, WiMAX
- Wideband communications
- LMDS/MMDS, point-to-point
- RF signal generators, arbitrary waveform generators

## GENERAL DESCRIPTION

The AD9780/AD9781/AD9783 include pin-compatible, high dynamic range, dual digital-to-analog converters (DACs) with 12-/14-/16-bit resolutions, and sample rates of up to 500 MSPS. The devices include specific features for direct conversion transmit applications, including gain and offset compensation, and they interface seamlessly with analog quadrature modulators such as the ADL5370.

A proprietary, dynamic output architecture permits synthesis of analog outputs even above Nyquist by shifting energy away from the fundamental and into the image frequency.

Full programmability is provided through a serial peripheral interface (SPI) port. Some pin-programmable features are also offered for those applications without a controller.

## PRODUCT HIGHLIGHTS

1. Low noise and intermodulation distortion (IMD) enable high quality synthesis of wideband signals.
2. Proprietary switching output for enhanced dynamic performance.
3. Programmable current outputs and dual auxiliary DACs provide flexibility and system enhancements.

## FUNCTIONAL BLOCK DIAGRAM

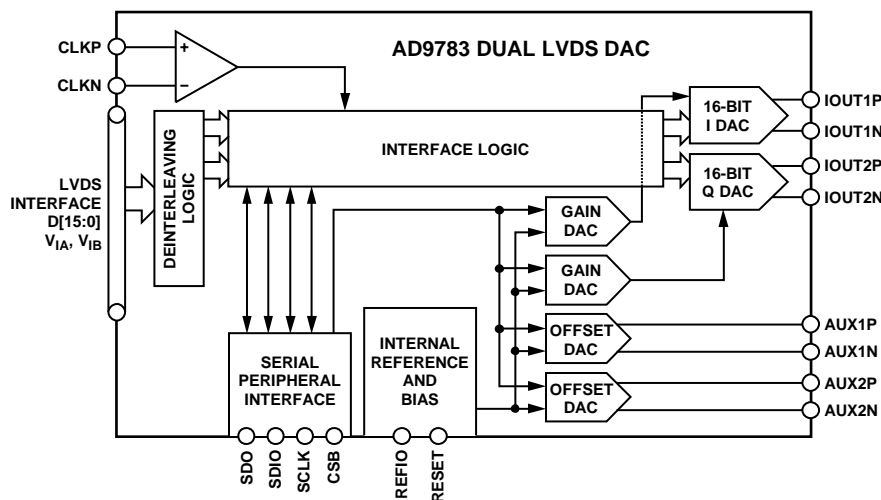


Figure 1.

Rev. C

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## REVISION HISTORY

### 8/2017—Rev. B to Rev. C

|                           |    |
|---------------------------|----|
| Changes to Table 12 ..... | 22 |
|---------------------------|----|

### 6/2012—Rev. A to Rev. B

|  |    |
|--|----|
| Changes to Table 2 .....   | 4  |
| Changes to Pins 25, 26, 29, and 30 Description, Table 6 .....                    | 7  |
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| Changes to Ordering Guide .....  | 31 |

### 6/2008—Rev. 0 to Rev. A

|   |    |
|---|----|
| Changed Maximum Sample Rate to 500 MHz Throughout ..... | 1  |
| Changes to Table 3 .....                                | 4  |
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| Changes to Determining the SMP Value Section .....      | 25 |
| Added Evaluation Board Schematics Section .....         | 30 |
| Updated Outline Dimensions .....                        | 35 |

### 11/2007—Revision 0: Initial Version

## SPECIFICATIONS

### DC SPECIFICATIONS

$T_{MIN}$  to  $T_{MAX}$ , AVDD33 = 3.3 V, DVDD33 = 3.3 V, DVDD18 = 1.8 V, CVDD18 = 1.8 V,  $I_{OUTFS}$  = 20 mA maximum sample rate, unless otherwise noted.

Table 1.

| Parameter                              | AD9780       |      |              | AD9781       |      |              | AD9783       |      |              | Unit   |
|--|--------------|------|--------------|--------------|------|--------------|--------------|------|--------------|--------|
|  | Min          | Typ  | Max          | Min          | Typ  | Max          | Min          | Typ  | Max          |        |
| RESOLUTION                             | 12           |      |              | 14           |      |              | 16           |      |              | Bits   |
| ACCURACY                               |              |      |              |              |      |              |              |      |              |        |
| Differential Nonlinearity (DNL)        | ±0.13        |      |              | ±0.5         |      |              | ±2           |      |              | LSB    |
| Integral Nonlinearity (INL)            | ±0.25        |      |              | ±1           |      |              | ±4           |      |              | LSB    |
| MAIN DAC OUTPUTS                       |              |      |              |              |      |              |              |      |              |        |
| Offset Error                           | -0.001       | 0    | +0.001       | -0.001       | 0    | +0.001       | -0.001       | 0    | +0.001       | % FSR  |
| Gain Error (with Internal Reference)   | ±2           |      |              | ±2           |      |              | ±2           |      |              | % FSR  |
| Full-Scale Output Current <sup>1</sup> | 8.66         | 20.2 | 31.66        | 8.66         | 20.2 | 31.66        | 8.66         | 20.2 | 31.66        | mA     |
| Output Compliance Range                | -1.0         |      | +1.0         | -1.0         |      | +1.0         | -1.0         |      | +1.0         | V      |
| Output Resistance                      | 10           |      |              | 10           |      |              | 10           |      |              | MΩ     |
| Main DAC Monotonicity Guaranteed       |              |      |              |              |      |              |              |      |              |        |
| MAIN DAC TEMPERATURE DRIFT             |              |      |              |              |      |              |              |      |              |        |
| Offset                                 | 0.04         |      |              | 0.04         |      |              | 0.04         |      |              | ppm/°C |
| Gain                                   | 100          |      |              | 100          |      |              | 100          |      |              | ppm/°C |
| Reference Voltage                      | 30           |      |              | 30           |      |              | 30           |      |              | ppm/°C |
| AUX DAC OUTPUTS                        |              |      |              |              |      |              |              |      |              |        |
| Resolution                             | 10           |      |              | 10           |      |              | 10           |      |              | Bits   |
| Full-Scale Output Current              | -2           |      | +2           | -2           |      | +2           | -2           |      | +2           | mA     |
| Output Compliance Range (Source)       | 0            |      | 1.6          | 0            |      | 1.6          | 0            |      | 1.6          | V      |
| Output Compliance Range (Sink)         | 0.8          |      | 1.6          | 0.8          |      | 1.6          | 0.8          |      | 1.6          | V      |
| Output Resistance                      | 1            |      |              | 1            |      |              | 1            |      |              | MΩ     |
| AUX DAC Monotonicity Guaranteed        |              |      |              |              |      |              |              |      |              |        |
| REFERENCE                              |              |      |              |              |      |              |              |      |              |        |
| Internal Reference Voltage             | 1.2          |      |              | 1.2          |      |              | 1.2          |      |              | V      |
| Output Resistance                      | 5            |      |              | 5            |      |              | 5            |      |              | kΩ     |
| ANALOG SUPPLY VOLTAGES                 |              |      |              |              |      |              |              |      |              |        |
| AVDD33                                 | 3.13         | 3.3  | 3.47         | 3.13         | 3.3  | 3.47         | 3.13         | 3.3  | 3.47         | V      |
| CVDD18                                 | 1.70         | 1.8  | 1.90         | 1.70         | 1.8  | 1.90         | 1.70         | 1.8  | 1.90         | V      |
| DIGITAL SUPPLY VOLTAGES                |              |      |              |              |      |              |              |      |              |        |
| DVDD33                                 | 3.13         | 3.3  | 3.47         | 3.13         | 3.3  | 3.47         | 3.13         | 3.3  | 3.47         | V      |
| DVDD18                                 | 1.70         | 1.8  | 1.90         | 1.70         | 1.8  | 1.90         | 1.70         | 1.8  | 1.90         | V      |
| POWER CONSUMPTION                      |              |      |              |              |      |              |              |      |              |        |
| $f_{DAC}$ = 500 MSPS, $I_F$ = 20 MHz   | $V \times I$ |      | $V \times I$ | $V \times I$ |      | $V \times I$ | $V \times I$ |      | $V \times I$ | mW     |
| $f_{DAC}$ = 500 MSPS, $I_F$ = 10 MHz   | 440          |      |              | 440          |      |              | 440          |      |              | mW     |
| Power-Down Mode                        | 3            |      | 5            | 3            |      | 5            | 3            |      | 35           | mW     |
| SUPPLY CURRENTS <sup>2</sup>           |              |      |              |              |      |              |              |      |              |        |
| AVDD33                                 | 55           |      | 58           | 55           |      | 58           | 55           |      | 58           | mA     |
| CVDD18                                 | 34           |      | 38           | 34           |      | 38           | 34           |      | 38           | mA     |
| DVDD33                                 | 13           |      | 15           | 13           |      | 15           | 13           |      | 15           | mA     |
| DVDD18                                 | 68           |      | 85           | 68           |      | 85           | 68           |      | 85           | mA     |

<sup>1</sup> Based on a 10 kΩ external resistor.

<sup>2</sup>  $f_{DAC}$  = 500 MSPS,  $f_{OUT}$  = 20 MHz.

**DIGITAL SPECIFICATIONS**

$T_{MIN}$  to  $T_{MAX}$ , AVDD33 = 3.3 V, DVDD33 = 3.3 V, DVDD18 = 1.8 V, CVDD18 = 1.8 V,  $I_{OUTFS}$  = 20 mA maximum sample rate, unless otherwise noted.

**Table 2.**

| Parameter   | Min  | Typ | Max  | Unit     |
|---|------|-----|------|----------|
| <b>DAC CLOCK INPUT (CLKP, CLKN)</b>                       |      |     |      |          |
| Differential Peak-to-Peak Voltage (CLKP – CLKN)           | 400  | 800 | 1600 | mV       |
| Common-Mode Voltage                                       | 300  | 400 | 500  | mV       |
| Maximum Clock Rate  | 500  |     |      | MSPS     |
| <b>DAC CLOCK TO ANALOG OUTPUT DATA LATENCY</b>            |      |     | 7    | Cycles   |
| <b>SERIAL PERIPHERAL INTERFACE (CMOS INTERFACE)</b>       |      |     |      |          |
| Maximum Clock Rate (SCLK)                                 |      |     | 40   | MHz      |
| Minimum Pulse Width High                                  |      |     | 12.5 | ns       |
| Minimum Pulse Width Low                                   |      |     | 12.5 | ns       |
| Setup Time, SDI to SCLK ( $t_{DS}$ )                      | 2.0  |     |      | ns       |
| Hold Time, SDI to SCLK ( $t_{DH}$ )                       | 0.2  |     |      | ns       |
| Data Valid, SDO to SCLK, ( $t_{DV}$ )                     | 2.3  |     |      | ns       |
| Setup time, CSB to SCLK ( $t_{DCSB}$ )                    |      | 1.4 |      | ns       |
| <b>SERIAL PERIPHERAL INTERFACE LOGIC LEVELS</b>           |      |     |      |          |
| Input Logic High  | 2.0  |     |      | V        |
| Input Logic Low   |      |     | 0.8  | V        |
| <b>DIGITAL INPUT DATA (LVDS INTERFACE)</b>                |      |     |      |          |
| Input Voltage Range, $V_{IA}$ or $V_{IB}$                 | 800  |     | 1600 | mV       |
| Input Differential Threshold, $V_{IDTH}$                  | -100 |     | +100 | mV       |
| Input Differential Hysteresis, $V_{IDTHH}$ to $V_{IDTHL}$ |      | 20  |      | mV       |
| Input Differential Input Impedance, $R_{IN}$              | 80   |     | 120  | $\Omega$ |
| Maximum LVDS Input Rate (per DAC)                         | 500  |     |      | MSPS     |

**AC SPECIFICATIONS**

$T_{MIN}$  to  $T_{MAX}$ ,  $AVDD33 = 3.3$  V,  $DVDD33 = 3.3$  V,  $DVDD18 = 1.8$  V,  $CVDD18 = 1.8$  V,  $I_{OUTFS} = 20$  mA, maximum sample rate, unless otherwise noted.

**Table 3.**

| Parameter   | AD9780 |        |     | AD9781 |        |     | AD9783 |      |     | Unit |
|---|--------|--------|-----|--------|--------|-----|--------|------|-----|------|
|   | Min    | Typ    | Max | Min    | Typ    | Max | Min    | Typ  | Max |      |
| SPURIOUS FREE DYNAMIC RANGE (SFDR)                              |        |        |     |        |        |     |        |      |     |      |
| $f_{DAC} = 500$ MSPS, $f_{OUT} = 20$ MHz                        |        | 79     |     |        | 78     |     |        | 80   |     | dBc  |
| $f_{DAC} = 500$ MSPS, $f_{OUT} = 120$ MHz                       |        | 67     |     |        | 66     |     |        | 68   |     | dBc  |
| $f_{DAC} = 500$ MSPS, $f_{OUT} = 380$ MHz (Mix Mode)            |        | 55     |     |        | 58     |     |        | 62   |     | dBc  |
| $f_{DAC} = 500$ MSPS, $f_{OUT} = 480$ MHz (Mix Mode)            |        | 58     |     |        | 62     |     |        | 59   |     | dBc  |
| TWO-TONE INTERMODULATION DISTORTION (IMD)                       |        |        |     |        |        |     |        |      |     |      |
| $f_{DAC} = 500$ MSPS, $f_{OUT} = 20$ MHz                        |        | 91     |     |        | 93     |     |        | 86   |     | dBc  |
| $f_{DAC} = 500$ MSPS, $f_{OUT} = 120$ MHz                       |        | 80     |     |        | 75     |     |        | 79   |     | dBc  |
| $f_{DAC} = 500$ MSPS, $f_{OUT} = 380$ MHz (Mix Mode)            |        | 69     |     |        | 70     |     |        | 64   |     | dBc  |
| $f_{DAC} = 500$ MSPS, $f_{OUT} = 480$ MHz (Mix Mode)            |        | 60.5   |     |        | 61.5   |     |        | 66   |     | dBc  |
| ONE-TONE NOISE SPECTRAL DENSITY (NSD)                           |        |        |     |        |        |     |        |      |     |      |
| $f_{DAC} = 500$ MSPS, $f_{OUT} = 40$ MHz                        |        | -157   |     |        | -162   |     |        | -165 |     | dBc  |
| $f_{DAC} = 500$ MSPS, $f_{OUT} = 120$ MHz                       |        | -154.5 |     |        | -156.5 |     |        | -157 |     | dBc  |
| $f_{DAC} = 500$ MSPS, $f_{OUT} = 380$ MHz (Mix Mode)            |        | -153   |     |        | -153   |     |        | -154 |     | dBc  |
| $f_{DAC} = 500$ MSPS, $f_{OUT} = 480$ MHz (Mix Mode)            |        | -152   |     |        | -152   |     |        | -153 |     | dBc  |
| W-CDMA ADJACENT CHANNEL LEAKAGE RATIO (ACLR),<br>SINGLE CARRIER |        |        |     |        |        |     |        |      |     |      |
| $f_{DAC} = 491.52$ MSPS, $f_{OUT} = 20$ MHz                     |        | -81    |     |        | -82.5  |     |        | -82  |     | dBc  |
| $f_{DAC} = 491.52$ MSPS, $f_{OUT} = 80$ MHz                     |        | -80    |     |        | -82.5  |     |        | -81  |     | dBc  |
| $f_{DAC} = 491.52$ MSPS, $f_{OUT} = 411.52$ MHz                 |        | -71    |     |        | -68    |     |        | -69  |     | dBc  |
| $f_{DAC} = 491.52$ MSPS, $f_{OUT} = 471.52$ MHz                 |        | -69    |     |        | -69    |     |        | -70  |     | dBc  |

## ABSOLUTE MAXIMUM RATINGS

Table 4.

| Parameter   | With Respect to  | Rating                      |
|---|------------------|-----------------------------|
| AVDD33, DVDD33  | AGND, DGND, CGND | -0.3 V to +3.6 V            |
| DVDD18, CVDD18  | AGND, DGND, CGND | -0.3 V to +1.98 V           |
| AGND  | DGND, CGND       | -0.3 V to +0.3 V            |
| DGND  | AGND, CGND       | -0.3 V to +0.3 V            |
| CGND  | AGND, DGND       | -0.3 V to +0.3 V            |
| REFIO   | AGND             | -0.3 V to<br>AVDD33 + 0.3 V |
| IOUT1P, IOUT1N,<br>IOUT2P, IOUT2N,<br>AUX1P, AUX1N,<br>AUX2P, AUX2N | AGND             | -1.0 V to<br>AVDD33 + 0.3 V |
| D15 to D0   | DGND             | -0.3 V to<br>DVDD33 + 0.3 V |
| CLKP, CLKN  | CGND             | -0.3 V to<br>CVDD18 + 0.3 V |
| CSB, SCLK, SDIO, SDO  | DGND             | -0.3 V to<br>DVDD33 + 0.3 V |
| Junction Temperature  |                  | +125°C                      |
| Storage Temperature   |                  | -65°C to +150°C             |

## THERMAL RESISTANCE

Thermal resistance is tested using a JEDEC standard 4-layer thermal test board with no airflow.

Table 5.

| Package Type                          | $\theta_{JA}$ | Unit |
|---------------------------------------|---------------|------|
| CP-72-1 (Exposed Pad Soldered to PCB) | 25            | °C/W |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

# PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

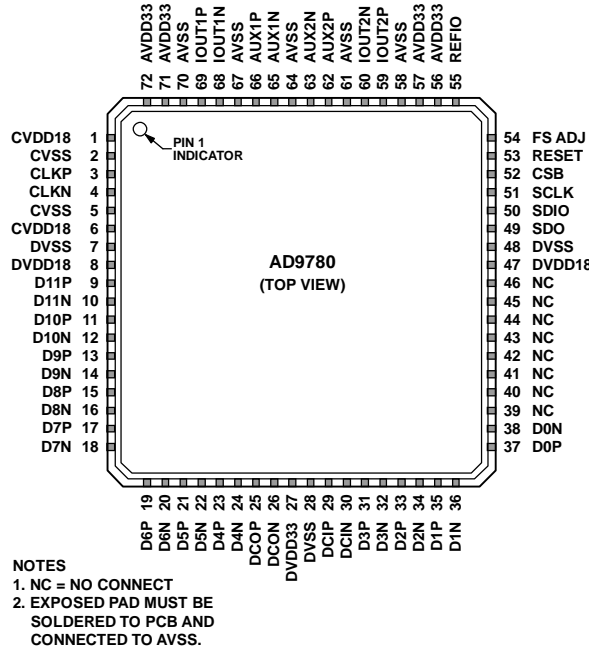
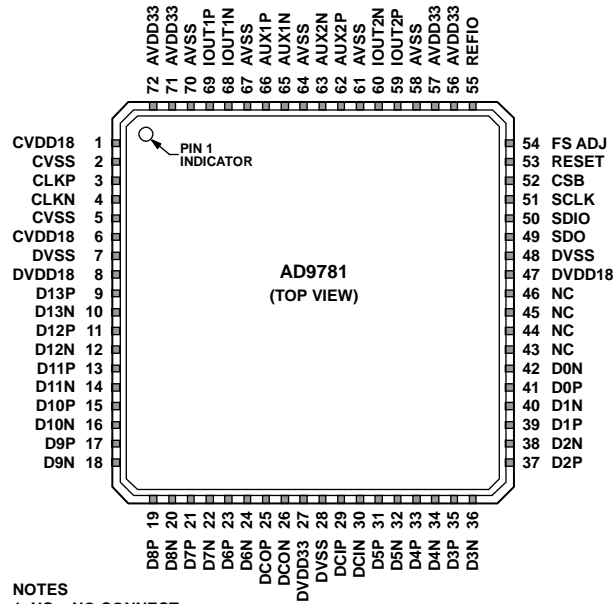


Figure 2. AD9780 Pin Configuration

Table 6. AD9780 Pin Function Descriptions

| Pin No.            | Mnemonic               | Description   |
|--------------------|------------------------|---|
| 1, 6               | CVDD18                 | Clock Supply Voltage (1.8 V).   |
| 2, 5               | CVSS                   | Clock Supply Return.  |
| 3, 4               | CLKP, CLKN             | Differential DAC Sampling Clock Input.  |
| 7, 28, 48          | DVSS                   | Digital Common.   |
| 8, 47              | DVDD18                 | Digital Supply Voltage (1.8 V).   |
| 9 to 24, 31 to 38  | D11P, D11N to D0P, D0N | LVDS Data Inputs. D11 is the MSB, D0 is the LSB.  |
| 25, 26             | DCOP, DCON             | Differential Data Clock Output. Clock at the DAC sample rate.                                       |
| 27                 | DVDD33                 | Digital Input and Output Pad Ring Supply Voltage (3.3 V).   |
| 29, 30             | DCIP, DCIN             | Differential Data Clock Input. Clock aligned with input data.                                       |
| 39 to 46           | NC                     | No Connection. Leave these pins floating.   |
| 49                 | SDO                    | Serial Port Data Output.  |
| 50                 | SDIO                   | Serial Port Data Input (4-Wire Mode) or Bidirectional Serial Data Line (3-Wire Mode).               |
| 51                 | SCLK                   | Serial Port Clock Input.  |
| 52                 | CSB                    | Serial Port Chip Select (Active Low).   |
| 53                 | RESET                  | Chip Reset (Active High).   |
| 54                 | FS ADJ                 | Full-Scale Current Output Adjust.   |
| 55                 | REFIO                  | Analog Reference Input/Output (1.2 V Nominal).  |
| 56, 57, 71, 72     | AVDD33                 | Analog Supply Voltage (3.3 V).  |
| 58, 61, 64, 67, 70 | AVSS                   | Analog Common.  |
| 59                 | IOUT2P                 | DAC Current Output. Full-scale current is sourced when all data bits are 1s.                        |
| 60                 | IOUT2N                 | Complementary DAC Current Output. Full-scale current is sourced when all data bits are 0s.          |
| 62, 63             | AUX2P, AUX2N           | Differential Auxiliary DAC Current Output (Channel 2).  |
| 65, 66             | AUX1N, AUX1P           | Differential Auxiliary DAC Current Output (Channel 1).  |
| 68                 | IOUT1N                 | Complementary DAC Current Output. Full-scale current is sourced when all data bits are 0s.          |
| 69                 | IOUT1P                 | DAC Current Output. Full-scale current is sourced when all data bits are 1s.                        |
| Heat Sink Pad      | N/A                    | The heat sink pad on the bottom of the package must be soldered to the PCB plane that carries AVSS. |



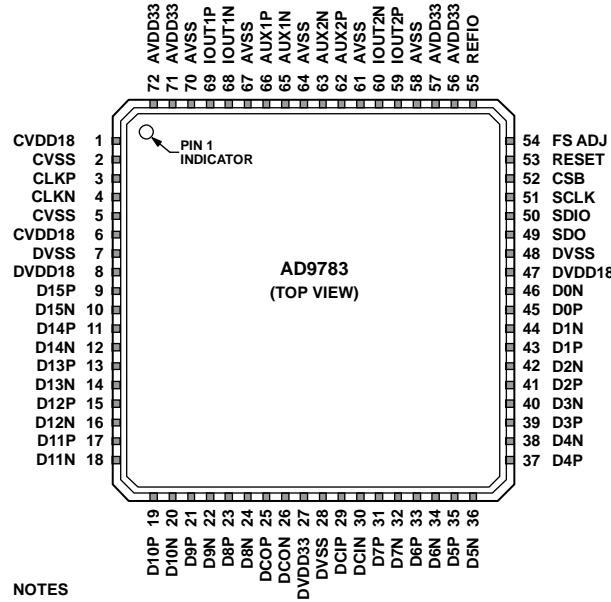
NOTES  
 1. NC = NO CONNECT  
 2. EXPOSED PAD MUST BE SOLDERED TO PCB AND CONNECTED TO AVSS.

08938F-003

Figure 3. AD9781 Pin Configuration

Table 7. AD9781 Pin Function Descriptions

| Pin No.            | Mnemonic               | Description   |
|--------------------|------------------------|---|
| 1, 6               | CVDD18                 | Clock Supply Voltage (1.8 V).   |
| 2, 5               | CVSS                   | Clock Supply Return.  |
| 3, 4               | CLKP, CLKN             | Differential DAC Sampling Clock Input.  |
| 7, 28, 48          | DVSS                   | Digital Common.   |
| 8, 47              | DVDD18                 | Digital Supply Voltage (1.8 V).   |
| 9 to 24, 31 to 42  | D13P, D13N to D0P, D0N | Data Inputs. D13 is the MSB, D0 is the LSB.   |
| 25, 26             | DCOP, DCON             | Differential Data Clock Output. Clock at the DAC sample rate.                                       |
| 27                 | DVDD33                 | Digital Input and Output Pad Ring Supply Voltage (3.3 V).   |
| 29, 30             | DCIP, DCIN             | Differential Data Clock Input. Clock aligned with input data.                                       |
| 43 to 46           | NC                     | No Connection. Leave these pins floating.   |
| 49                 | SDO                    | Serial Port Data Output.  |
| 50                 | SDIO                   | Serial Port Data Input (4-Wire Mode) or Bidirectional Serial Data Line (3-Wire Mode).               |
| 51                 | SCLK                   | Serial Port Clock Input.  |
| 52                 | CSB                    | Serial Port Chip Select (Active Low).   |
| 53                 | RESET                  | Chip Reset (Active High).   |
| 54                 | FS ADJ                 | Full-Scale Current Output Adjust.   |
| 55                 | REFIO                  | Analog Reference Input/Output (1.2 V Nominal).  |
| 56, 57, 71, 72     | AVDD33                 | Analog Supply Voltage (3.3 V).  |
| 58, 61, 64, 67, 70 | AVSS                   | Analog Common.  |
| 59                 | IOUT2P                 | DAC Current Output. Full-scale current is sourced when all data bits are 1s.                        |
| 60                 | IOUT2N                 | Complementary DAC Current Output. Full-scale current is sourced when all data bits are 0s.          |
| 62, 63             | AUX2P, AUX2N           | Differential Auxiliary DAC Current Output (Channel 2).  |
| 65, 66             | AUX1N, AUX1P           | Differential Auxiliary DAC Current Output (Channel 1).  |
| 68                 | IOUT1N                 | Complementary DAC Current Output. Full-scale current is sourced when all data bits are 0s.          |
| 69                 | IOUT1P                 | DAC Current Output. Full-scale current is sourced when all data bits are 1s.                        |
| Heat Sink Pad      | N/A                    | The heat sink pad on the bottom of the package must be soldered to the PCB plane that carries AVSS. |



NOTES  
 1. EXPOSED PAD MUST BE SOLDERED TO PCB AND CONNECTED TO AVSS.

06936-004

Figure 4. AD9783 Pin Configuration

Table 8. AD9783 Pin Function Descriptions

| Pin No.            | Mnemonic               | Description   |
|--------------------|------------------------|---|
| 1, 6               | CVDD18                 | Clock Supply Voltage (1.8 V).   |
| 2, 5               | CVSS                   | Clock Supply Return.  |
| 3, 4               | CLKP, CLKN             | Differential DAC Sampling Clock Input.  |
| 7, 28, 48          | DVSS                   | Digital Common.   |
| 8, 47              | DVDD18                 | Digital Supply Voltage (1.8 V).   |
| 9 to 24, 31 to 46  | D15P, D15N to D0P, D0N | LVDS Data Inputs. D15 is the MSB, D0 is the LSB.  |
| 25, 26             | DCOP, DCON             | Differential Data Clock Output. Clock at the DAC sample rate.                                       |
| 27                 | DVDD33                 | Digital Input and Output Pad Ring Supply Voltage (3.3 V).   |
| 29, 30             | DCIP, DCIN             | Differential Data Clock Input Clock aligned with input data.  |
| 49                 | SDO                    | Serial Port Data Output.  |
| 50                 | SDIO                   | Serial Port Data Input (4-Wire Mode) or Bidirectional Serial Data Line (3-Wire Mode).               |
| 51                 | SCLK                   | Serial Port Clock Input.  |
| 52                 | CSB                    | Serial Port Chip Select (Active Low).   |
| 53                 | RESET                  | Chip Reset (Active High).   |
| 54                 | FS ADJ                 | Full-Scale Current Output Adjust.   |
| 55                 | REFIO                  | Analog Reference Input/Output (1.2 V Nominal).  |
| 56, 57, 71, 72     | AVDD33                 | Analog Supply Voltage (3.3 V).  |
| 58, 61, 64, 67, 70 | AVSS                   | Analog Common.  |
| 59                 | IOUT2P                 | DAC Current Output. Full-scale current is sourced when all data bits are 1s.                        |
| 60                 | IOUT2N                 | Complementary DAC Current Output. Full-scale current is sourced when all data bits are 0s.          |
| 62, 63             | AUX2P, AUX2N           | Differential Auxiliary DAC Current Output (Channel 2).  |
| 65, 66             | AUX1N, AUX1P           | Differential Auxiliary DAC Current Output (Channel 1).  |
| 68                 | IOUT1N                 | Complementary DAC Current Output. Full-scale current is sourced when all data bits are 0s.          |
| 69                 | IOUT1P                 | DAC Current Output. Full-scale current is sourced when all data bits are 1s.                        |
| Heat Sink Pad      | N/A                    | The heat sink pad on the bottom of the package must be soldered to the PCB plane that carries AVSS. |

TYPICAL PERFORMANCE CHARACTERISTICS

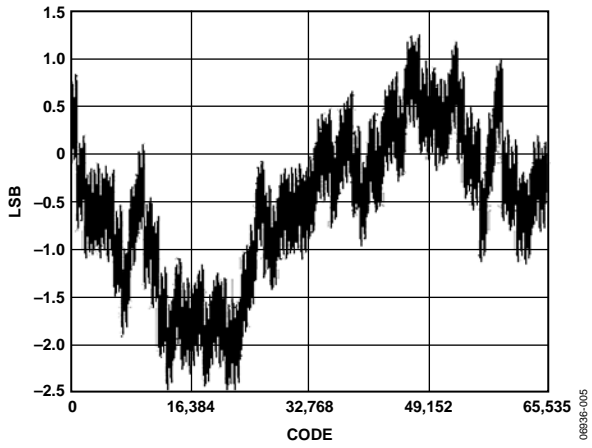


Figure 5. AD9783 INL,  $T_A = 85^\circ\text{C}$ ,  $FS = 20\text{ mA}$

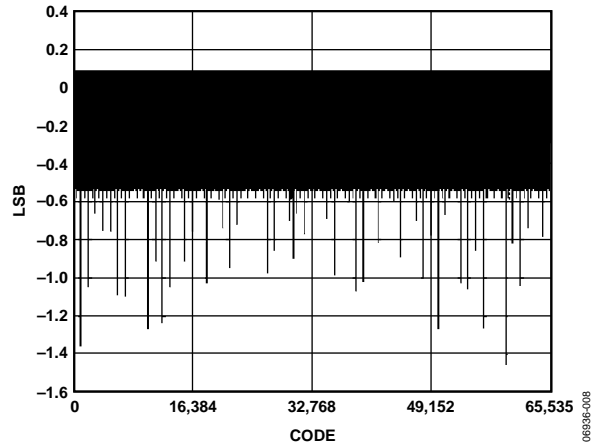


Figure 8. AD9783 DNL,  $T_A = 85^\circ\text{C}$ ,  $FS = 20\text{ mA}$

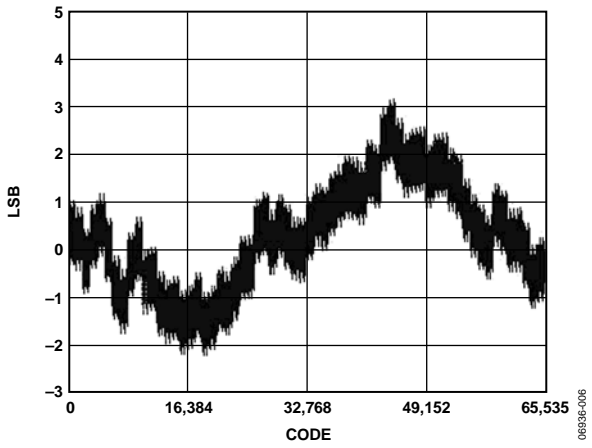


Figure 6. AD9783 INL,  $T_A = 25^\circ\text{C}$ ,  $FS = 20\text{ mA}$

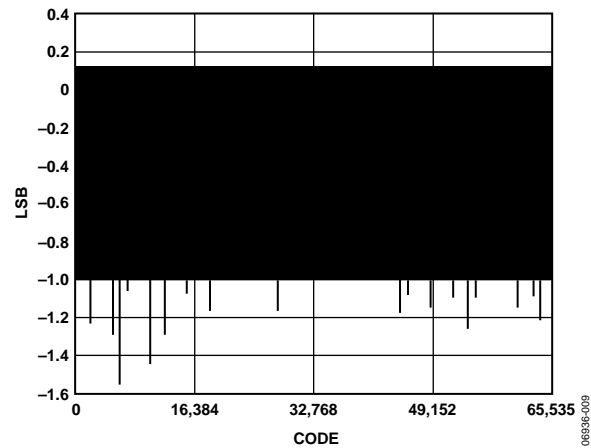


Figure 9. AD9783 DNL,  $T_A = 25^\circ\text{C}$ ,  $FS = 20\text{ mA}$

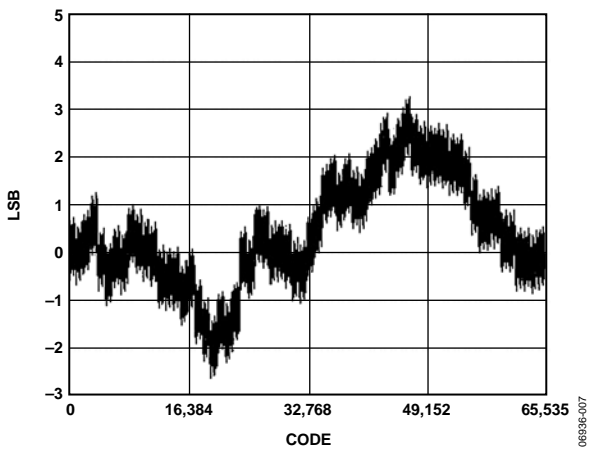


Figure 7. AD9783 INL,  $T_A = -40^\circ\text{C}$ ,  $FS = 20\text{ mA}$

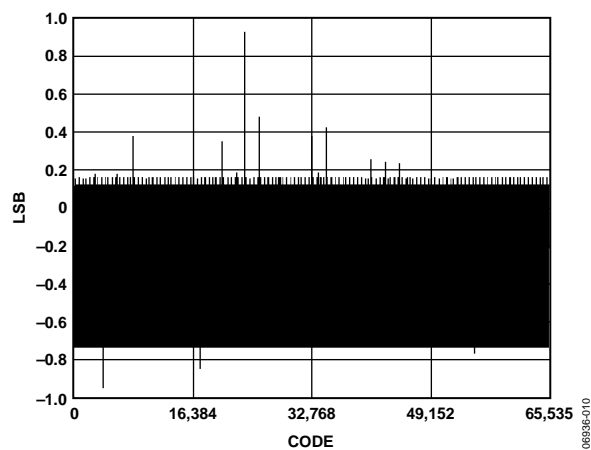


Figure 10. AD9783 DNL,  $T_A = -40^\circ\text{C}$ ,  $FS = 20\text{ mA}$

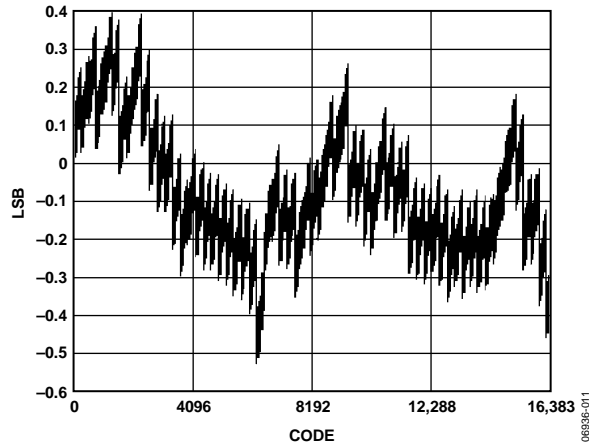


Figure 11. AD9781 INL,  $T_A = 85^\circ\text{C}$ ,  $FS = 20\text{ mA}$

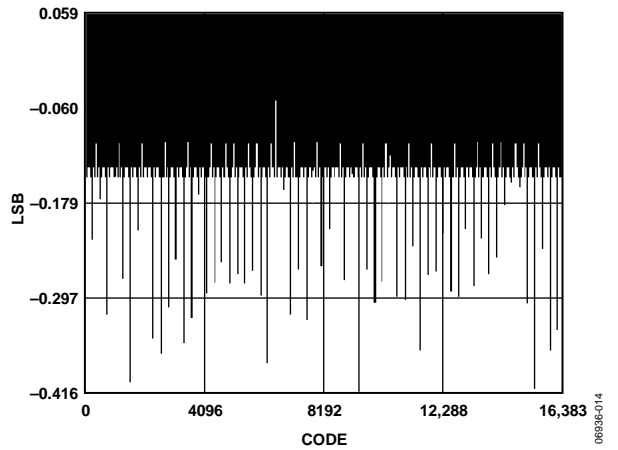


Figure 14. AD9781 DNL,  $T_A = 85^\circ\text{C}$ ,  $FS = 20\text{ mA}$

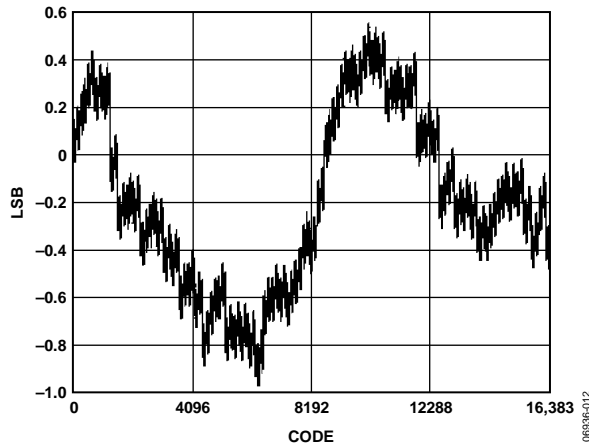


Figure 12. AD9781 INL,  $T_A = -40^\circ\text{C}$ ,  $FS = 20\text{ mA}$

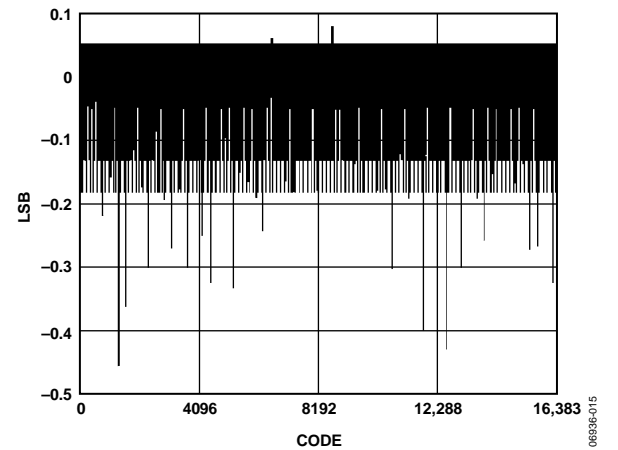


Figure 15. AD9781 DNL,  $T_A = -40^\circ\text{C}$ ,  $FS = 20\text{ mA}$

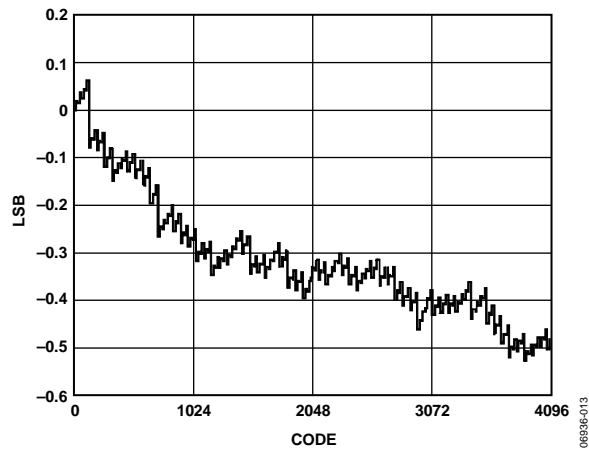


Figure 13. AD9780 INL,  $T_A = -40^\circ\text{C}$ ,  $FS = 20\text{ mA}$

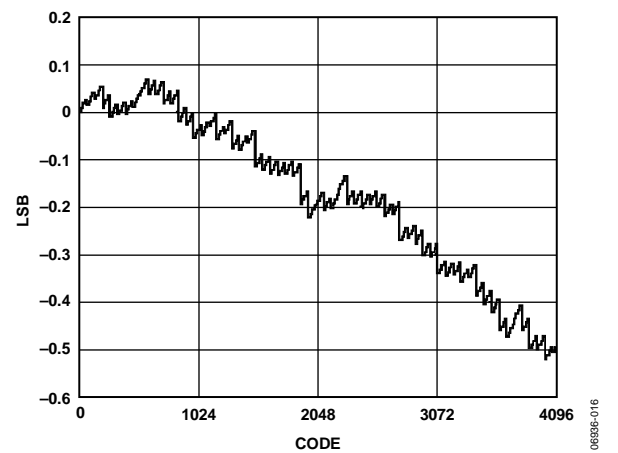


Figure 16. AD9780 INL,  $T_A = 85^\circ\text{C}$ ,  $FS = 20\text{ mA}$

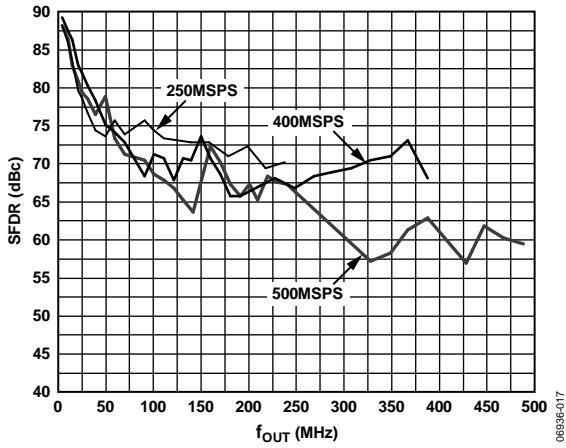


Figure 17. AD9783 SFDR vs.  $f_{OUT}$  Over  $f_{DAC}$  in Baseband and Mix Modes,  $FS = 20\text{ mA}$

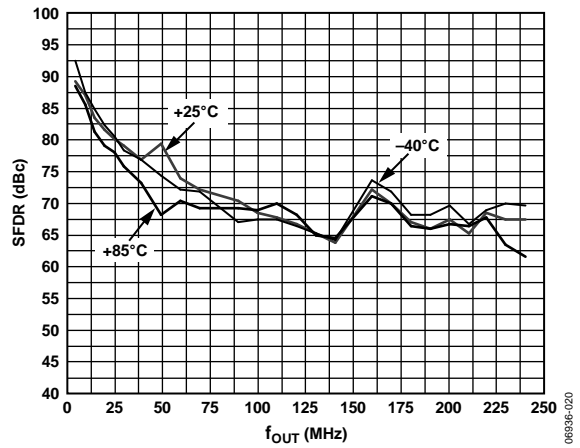


Figure 20. AD9783 SFDR vs.  $f_{OUT}$  Over Temperature, at 500 MSPS,  $FS = 20\text{ mA}$

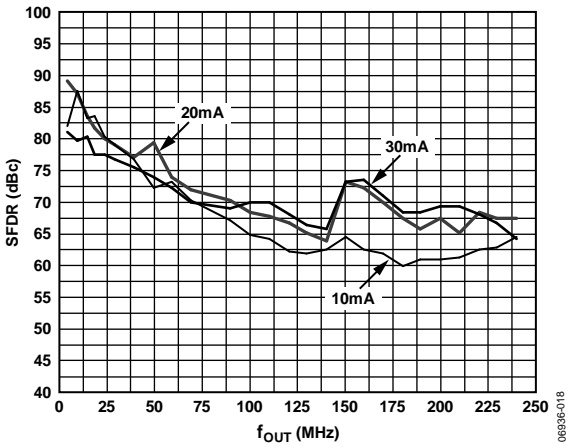


Figure 18. AD9783 SFDR vs.  $f_{OUT}$  Over Analog Output,  $T_A = 25^\circ\text{C}$ , at 500 MSPS

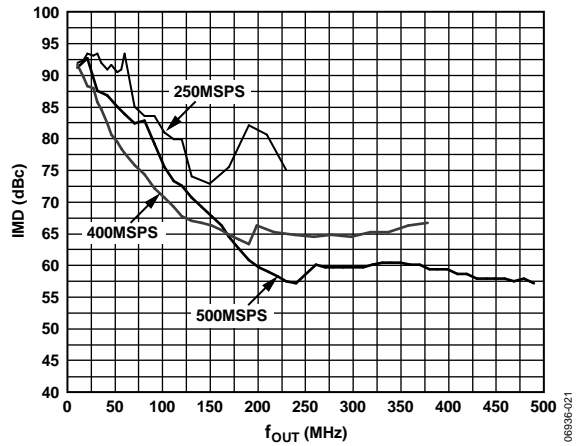


Figure 21. AD9783 IMD vs.  $f_{OUT}$  Over  $f_{DAC}$  in Baseband and Mix Modes,  $FS = 20\text{ mA}$

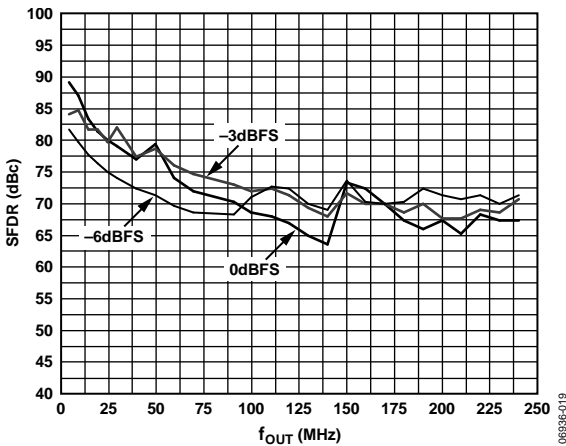


Figure 19. AD9783 SFDR vs.  $f_{OUT}$  Over Digital Input Level,  $T_A = 25^\circ\text{C}$ , at 500 MSPS,  $FS = 20\text{ mA}$

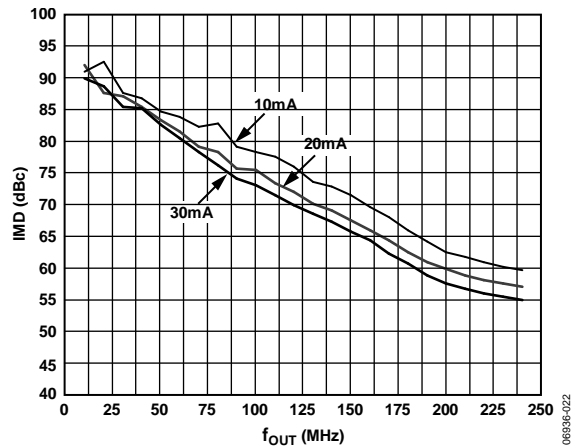


Figure 22. AD9783 IMD vs.  $f_{OUT}$  Over Analog Output,  $T_A = 25^\circ\text{C}$ , at 500 MSPS

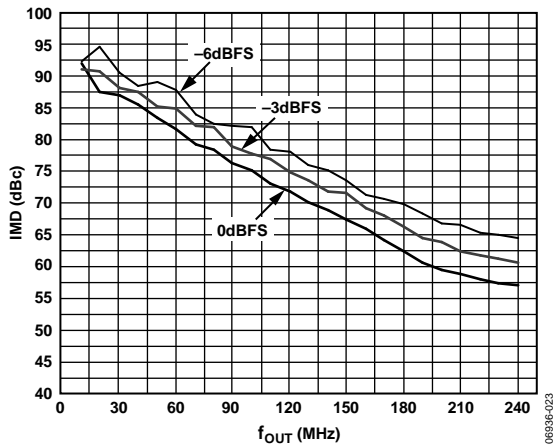


Figure 23. AD9783 IMD vs.  $f_{OUT}$  Over Digital Input Level,  $T_A = 25^\circ\text{C}$ , at 500 MSPS,  $FS = 20\text{ mA}$

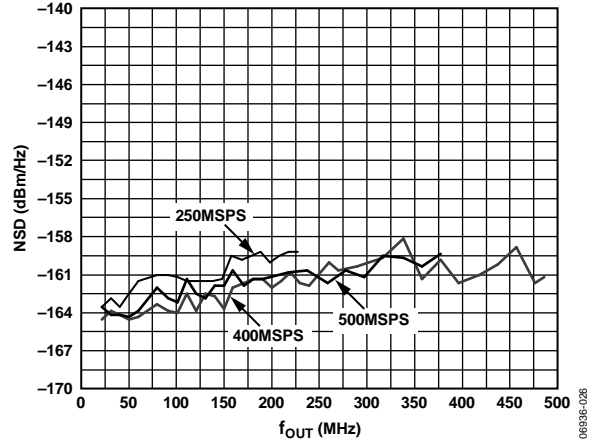


Figure 26. AD9783 Eight-Tone NSD vs.  $f_{OUT}$  Over  $f_{DAC}$  Baseband and Mix Modes,  $FS = 20\text{ mA}$

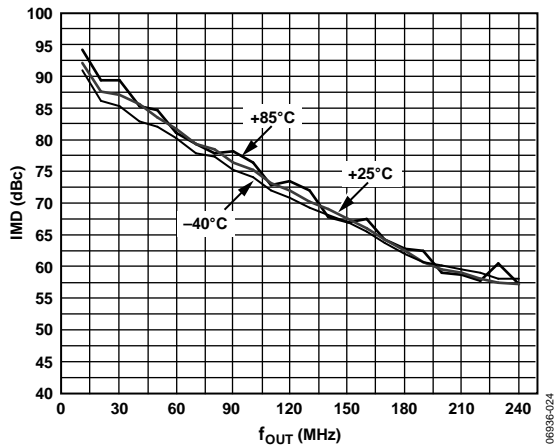


Figure 24. AD9783 IMD vs.  $f_{OUT}$  Over Temperature, at 500 MSPS,  $FS = 20\text{ mA}$

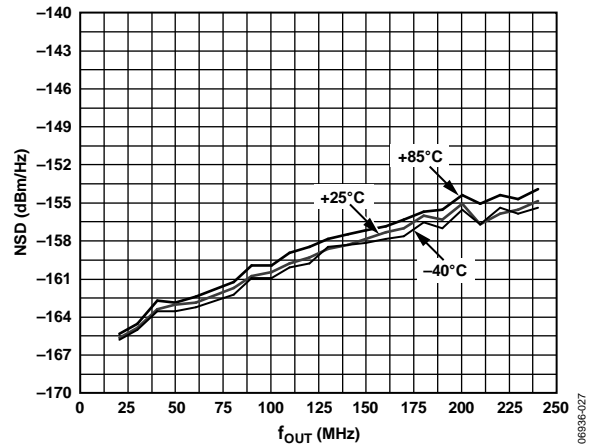


Figure 27. AD9783 One-Tone NSD vs.  $f_{OUT}$  Over Temperature, at 500 MSPS,  $FS = 20\text{ mA}$

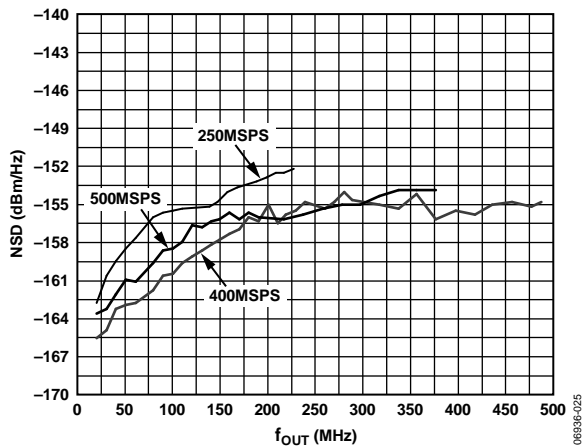


Figure 25. AD9783 One-Tone NSD vs.  $f_{OUT}$  Over  $f_{DAC}$  Baseband and Mix Modes,  $FS = 20\text{ mA}$

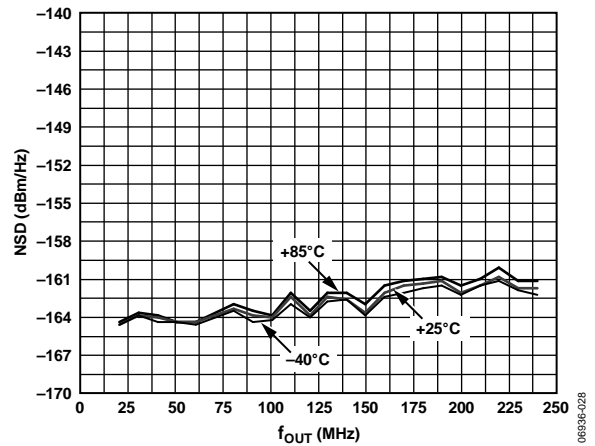


Figure 28. AD9783 Eight-Tone NSD vs.  $f_{OUT}$  Over Temperature, at 500 MSPS,  $FS = 20\text{ mA}$

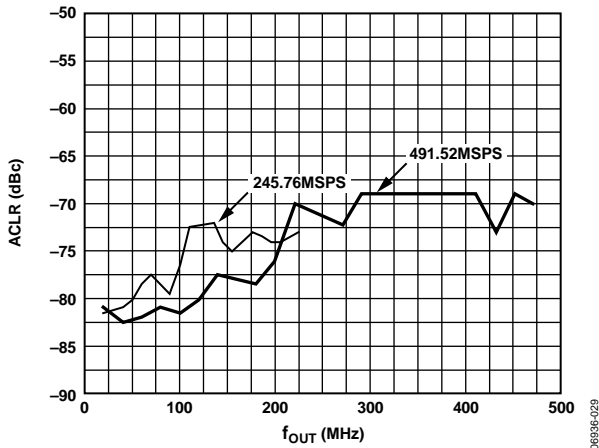


Figure 29. AD9783 ACLR for First Adjacent Band One-Carrier W-CDMA Baseband and Mix Modes, FS = 20 mA

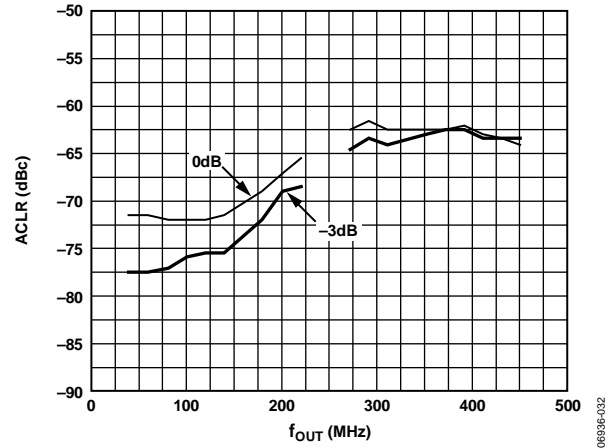


Figure 32. AD9783 ACLR for First Adjacent Channel Two-Carrier W-CDMA Over Digital Input Level Baseband and Mix Modes, at 491.52 MSPS, FS = 20 mA

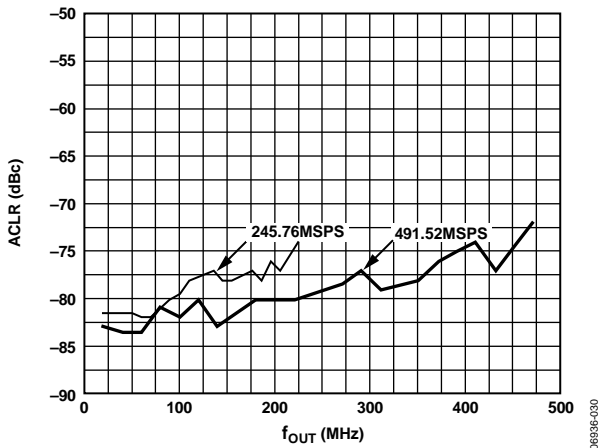


Figure 30. AD9783 ACLR for Second Adjacent Band One-Carrier W-CDMA Baseband and Mix Modes, FS = 20 mA

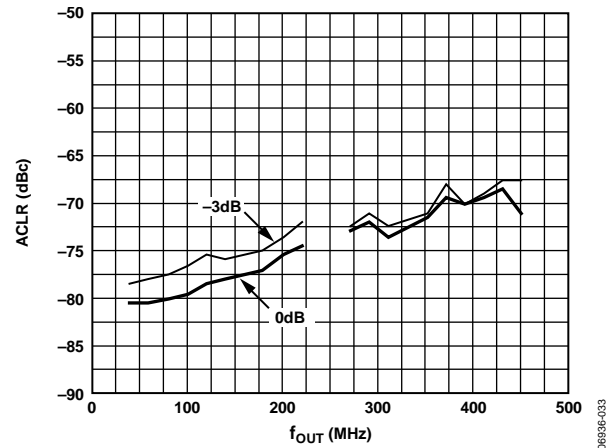


Figure 33. AD9783 ACLR for Second Adjacent Channel Two-Carrier W-CDMA Over Digital Input Level Baseband and Mix Modes, at 491.52 MSPS, FS = 20 mA

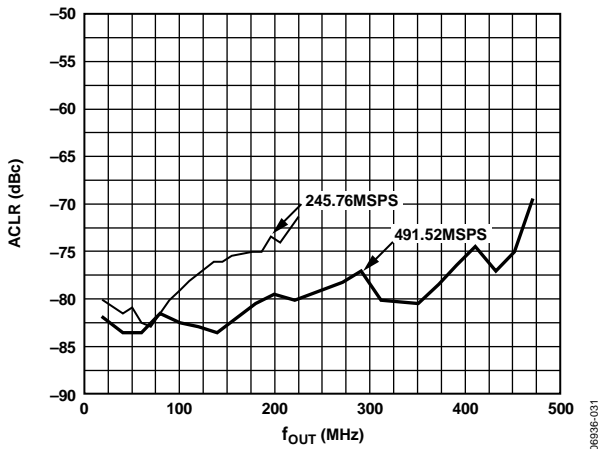


Figure 31. AD9783 ACLR for Third Adjacent Band One-Carrier W-CDMA Baseband and Mix Modes, FS = 20 mA

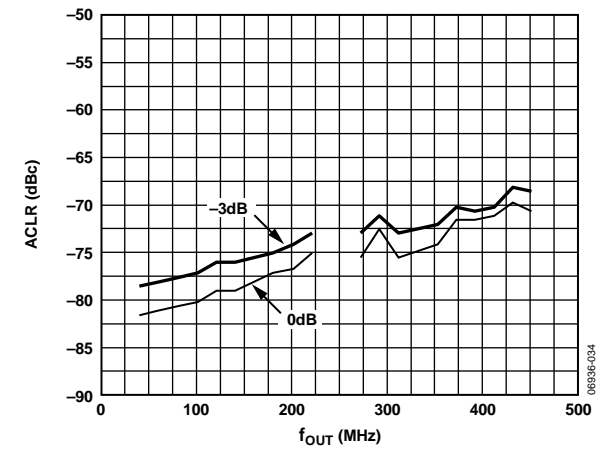


Figure 34. AD9783 ACLR for Third Adjacent Channel Two-Carrier W-CDMA Over Digital Input Level Baseband and Mix Modes, at 491.52 MSPS, FS = 20 mA

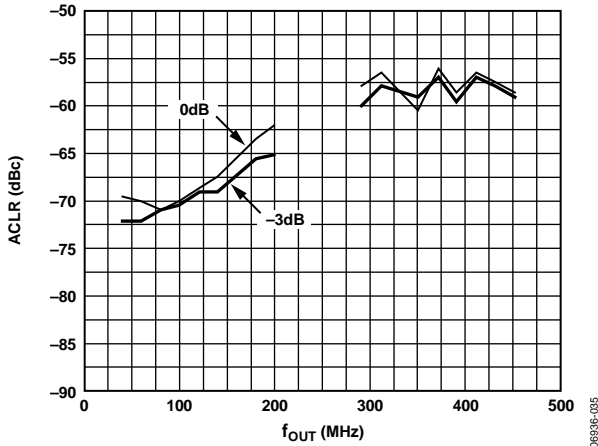


Figure 35. AD9783 ACLR for First Adjacent Channel Four-Carrier W-CDMA Over Digital Input Level Baseband and Mix Modes, at 491.52 MSPS, FS = 20 mA

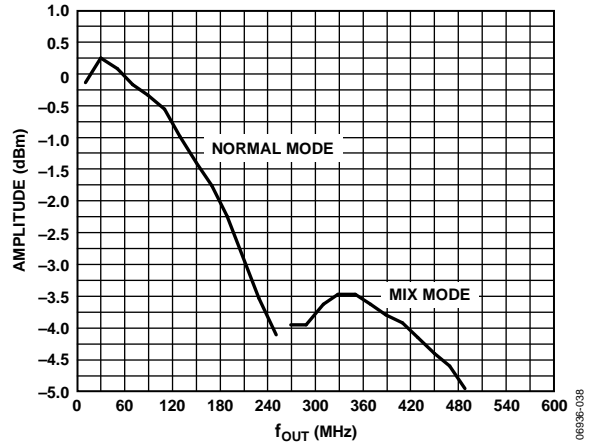


Figure 38. Nominal Power in the Fundamental, FS = 20 mA, at 500 MSPS, FS = 20 mA

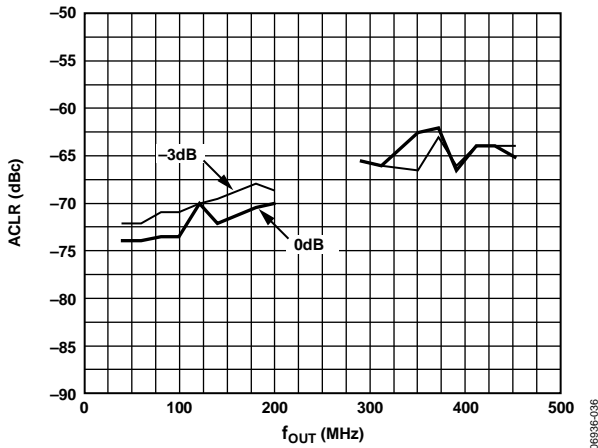


Figure 36. AD9783 ACLR for Second Adjacent Channel Four-Carrier W-CDMA Over Digital Input Level Baseband and Mix Modes, at 491.52 MSPS, FS = 20 mA

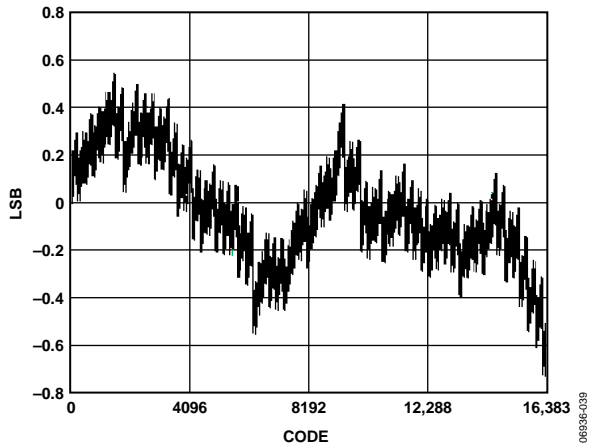


Figure 39. AD9781 INL, FS = 20 mA

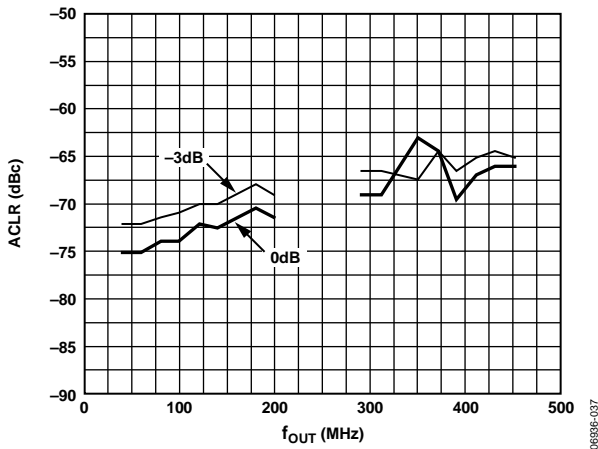


Figure 37. AD9783 ACLR for Third Adjacent Channel Four-Carrier W-CDMA Over Digital Input Level Baseband and Mix Modes, at 491.52 MSPS, FS = 20 mA

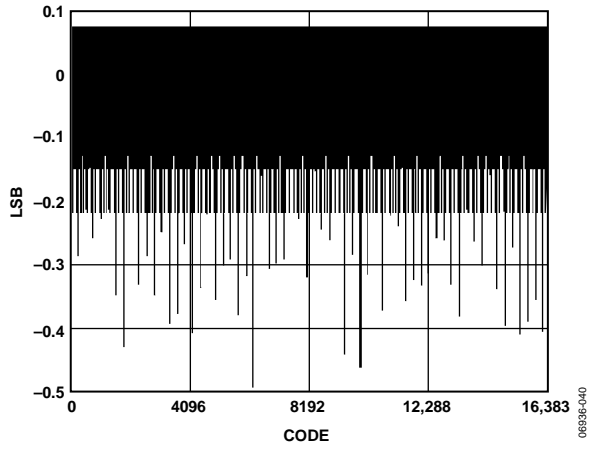


Figure 40. AD9781 DNL, FS = 20 mA

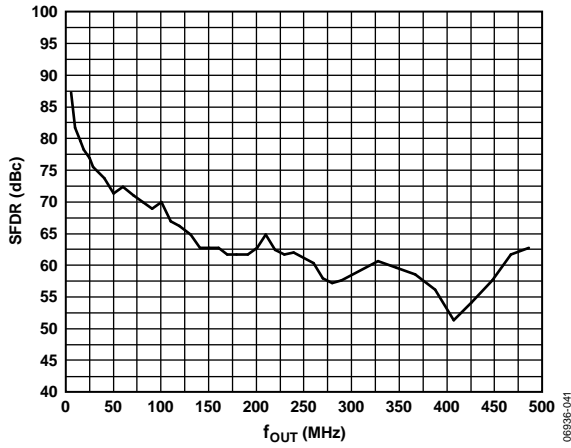


Figure 41. AD9781 SFDR vs.  $f_{OUT}$  in Baseband and Mix Modes, at 500 MSPS,  $FS = 20\text{ mA}$

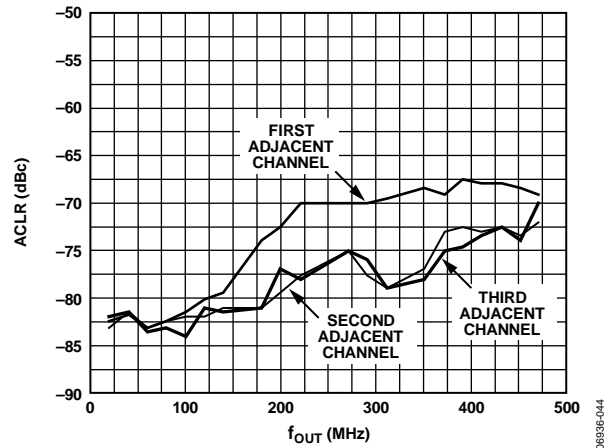


Figure 44. AD9781 ACLR for One-Carrier W-CDMA Baseband and Mix Modes, at 491.52 MSPS,  $FS = 20\text{ mA}$

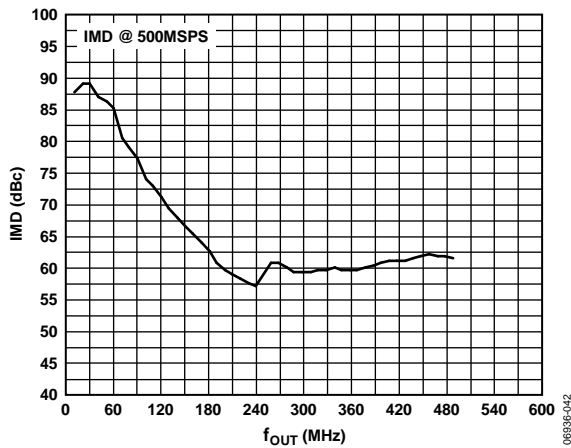


Figure 42. AD9781 IMD vs.  $f_{OUT}$  in Baseband and Mix Modes, at 500 MSPS,  $FS = 20\text{ mA}$

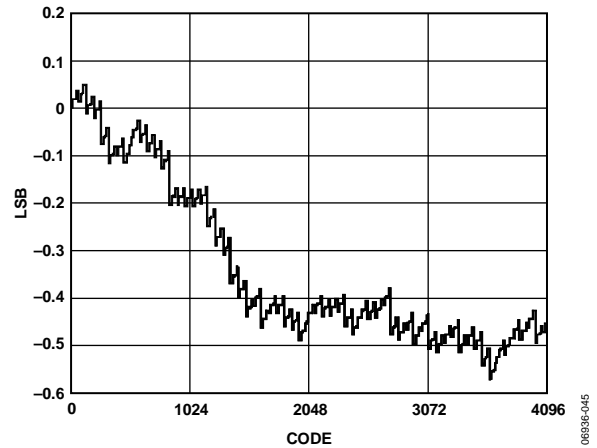


Figure 45. AD9780 INL,  $FS = 20\text{ mA}$

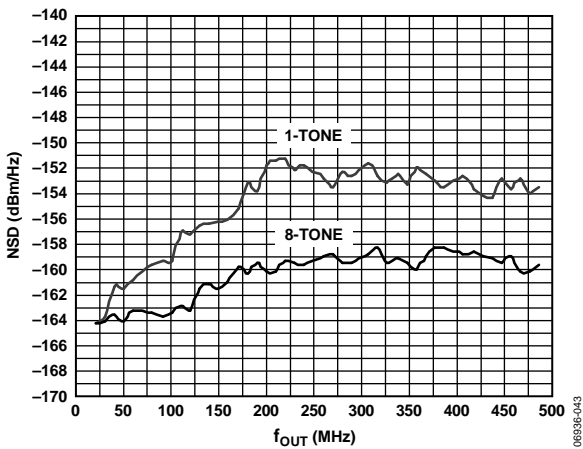


Figure 43. AD9781 One-Tone, Eight-Tone NSD vs.  $f_{OUT}$  in Baseband and Mix Modes, at 500 MSPS,  $FS = 20\text{ mA}$

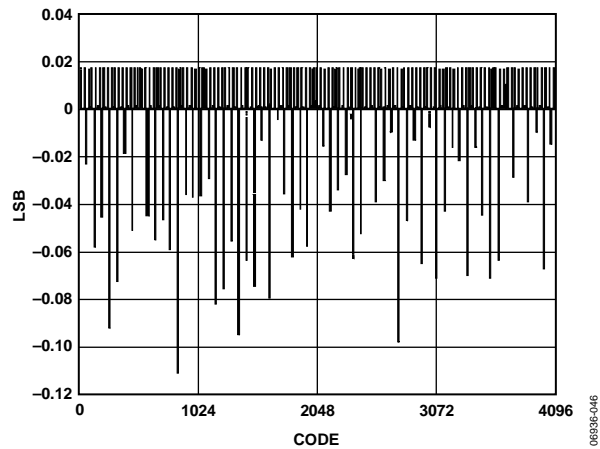


Figure 46. AD9780 DNL,  $FS = 20\text{ mA}$

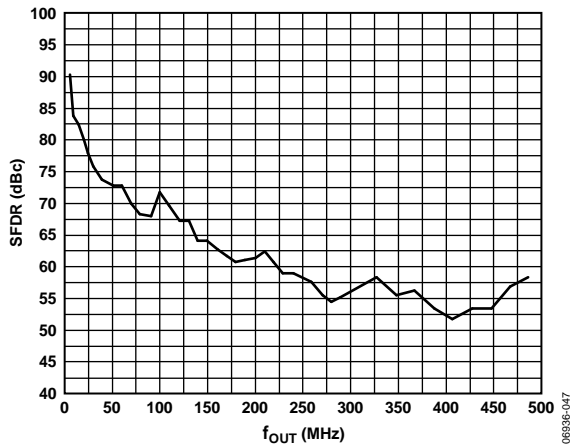


Figure 47. AD9780 SFDR vs.  $f_{OUT}$  in Baseband and Mix Modes, at 500 MSPS,  $FS = 20\text{ mA}$

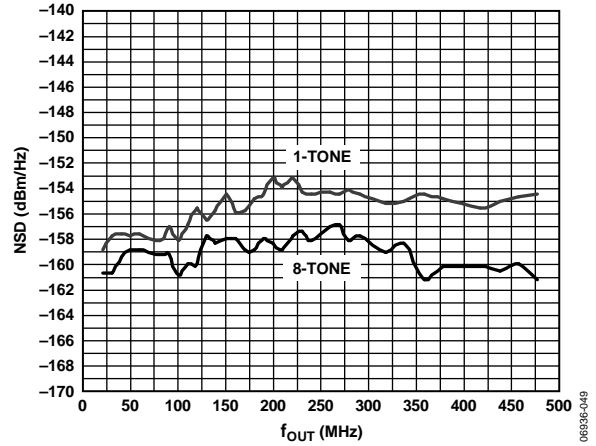


Figure 49. AD9780 One-Tone, Eight-Tone NSD vs.  $f_{OUT}$  in Baseband and Mix Modes, at 500 MSPS,  $FS = 20\text{ mA}$

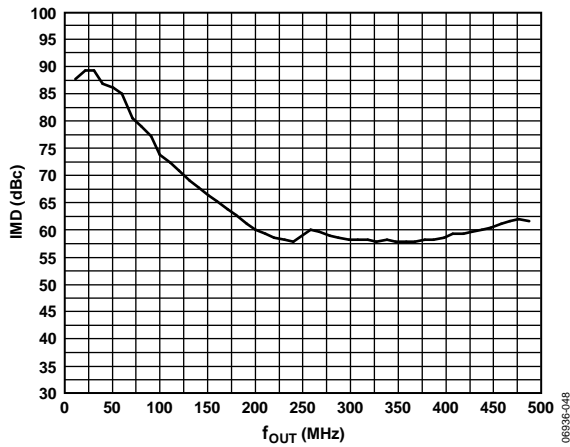


Figure 48. AD9780 IMD vs.  $f_{OUT}$  in Baseband and Mix Modes, at 500 MSPS,  $FS = 20\text{ mA}$

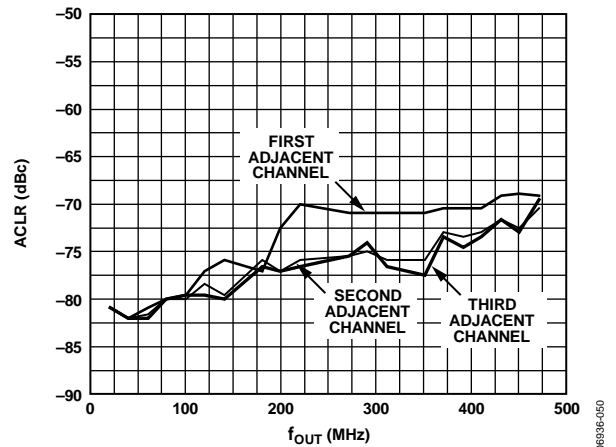


Figure 50. AD9780 ACLR for One-Carrier W-CDMA Baseband and Mix Modes, at 491.52 MSPS,  $FS = 20\text{ mA}$

## TERMINOLOGY

### Linearity Error or Integral Nonlinearity (INL)

Linearity error is defined as the maximum deviation of the actual analog output from the ideal output, determined by a straight line drawn from zero scale to full scale.

### Differential Nonlinearity (DNL)

DNL is the measure of the variation in analog value, normalized to full scale, associated with a 1 LSB change in digital input code.

### Monotonicity

A DAC is monotonic if the output either increases or remains constant as the digital input increases.

### Offset Error

Offset error is the deviation of the output current from the ideal of zero. For  $I_{OUTA}$ , 0 mA output is expected when the inputs are all 0s. For  $I_{OUTB}$ , 0 mA output is expected when all inputs are set to 1s.

### Gain Error

Gain error is the difference between the actual and ideal output span. The actual span is determined by the difference between the output when all inputs are set to 1s and the output when all inputs are set to 0s.

### Output Compliance Range

Output compliance range is the range of allowable voltage at the output of a current-output DAC. Operation beyond the maximum compliance limits can cause either output stage saturation or breakdown, resulting in nonlinear performance.

### Temperature Drift

Temperature drift is specified as the maximum change from the ambient (25°C) value to the value at either  $T_{MIN}$  or  $T_{MAX}$ . For offset and gain drift, the drift is reported in ppm of full-scale range (FSR) per degree Celsius. For reference drift, the drift is reported in ppm per degree Celsius.

### Power Supply Rejection

Power supply rejection is the maximum change in the full-scale output as the supplies are varied from minimum to maximum specified voltages.

### Settling Time

Settling time is the time required for the output to reach and remain within a specified error band around its final value, measured from the start of the output transition.

### Spurious-Free Dynamic Range (SFDR)

SFDR is the difference, in decibels, between the peak amplitude of the output signal and the peak spurious signal between dc and the frequency equal to half the input data rate.

### Total Harmonic Distortion (THD)

THD is the ratio of the rms sum of the first six harmonic components to the rms value of the measured fundamental. It is expressed as a percentage or in decibels.

### Signal-to-Noise Ratio (SNR)

SNR is the ratio of the rms value of the measured output signal to the rms sum of all other spectral components below the Nyquist frequency, excluding the first six harmonics and dc. The value for SNR is expressed in decibels.

### Adjacent Channel Leakage Ratio (ACLR)

ACLR is the ratio in dBc between the measured power within a channel relative to its adjacent channel.

### Complex Image Rejection

In a traditional two-part upconversion, two images are created around the second IF frequency. These images usually waste transmitter power and system bandwidth. By placing the real part of a second complex modulator in series with the first complex modulator, either the upper or lower frequency image near the second IF can be rejected.

## THEORY OF OPERATION

The AD9780/AD9781/AD9783 have a combination of features that make them very attractive for wired and wireless communications systems. The dual DAC architecture facilitates easy interface to common quadrature modulators when designing single sideband transmitters. In addition, the speed and performance of the devices allow wider bandwidths and more carriers to be synthesized than in previously available products.

All features and options are software programmable through the SPI port.

### SERIAL PERIPHERAL INTERFACE

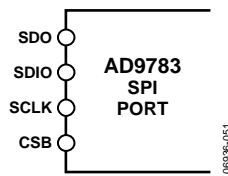


Figure 51. SPI Port

The serial peripheral interface (SPI) port is a flexible, synchronous serial communications port allowing easy interface to many industry-standard microcontrollers and microprocessors. The port is compatible with most synchronous transfer formats, including both the Motorola SPI and Intel® SSR protocols.

The interface allows read and write access to all registers that configure the AD9780/AD9781/AD9783. Single or multiple byte transfers are supported as well as MSB-first or LSB-first transfer formats. Serial data input/output can be accomplished through a single bidirectional pin (SDIO) or through two unidirectional pins (SDIO/SDO).

The serial port configuration is controlled by Register 0x00, Bits[7:6]. It is important to note that any change made to the serial port configuration occurs immediately upon writing to the last bit of this byte. Therefore, it is possible with a multibyte transfer to write to this register and change the configuration in the middle of a communication cycle. Care must be taken to compensate for the new configuration within the remaining bytes of the current communication cycle.

Use of a single-byte transfer when changing the serial port configuration is recommended to prevent unexpected device behavior.

### GENERAL OPERATION OF THE SERIAL INTERFACE

There are two phases to any communication cycle with the AD9780/AD9781/AD9783: Phase 1 and Phase 2. Phase 1 is the instruction cycle, which writes an instruction byte into the device. This byte provides the serial port controller with information regarding Phase 2 of the communication cycle: the data transfer cycle.

The Phase 1 instruction byte defines whether the upcoming data transfer is a read or write, the number of bytes in the data transfer, and a reference register address for the first byte of the data transfer. A logic high on the CSB pin followed by a logic low resets the SPI port to its initial state and defines the start of the instruction cycle. From this point, the next eight rising SCLK edges define the eight bits of the instruction byte for the current communication cycle.

The remaining SCLK edges are for Phase 2 of the communication cycle, which is the data transfer between the serial port controller and the system controller. Phase 2 can be a transfer of one, two, three, or four data bytes as determined by the instruction byte. Using multibyte transfers is usually preferred, although single-byte data transfers are useful to reduce CPU overhead or when only a single register access is required.

All serial port data is transferred to and from the device in synchronization with the SCLK pin. Input data is always latched on the rising edge of SCLK, whereas output data is always valid after the falling edge of SCLK. Register contents change immediately upon writing to the last bit of each transfer byte.

Anytime synchronization is lost, the device has the ability to asynchronously terminate an I/O operation whenever the CSB pin is taken to logic high. Any unwritten register content data is lost if the I/O operation is aborted. Taking CSB low then resets the serial port controller and restarts the communication cycle.

### INSTRUCTION BYTE

The instruction byte contains the information shown in Table 9.

Table 9.

| MSB |    |    |    |    |    | LSB |    |
|-----|----|----|----|----|----|-----|----|
| B7  | B6 | B5 | B4 | B3 | B2 | B1  | B0 |
| R/W | N1 | N0 | A4 | A3 | A2 | A1  | A0 |

Bit 7, R/W, determines whether a read or a write data transfer occurs after the instruction byte write. Logic 1 indicates a read operation. Logic 0 indicates a write operation.

Bits[6:5], N1 and N0, determine the number of bytes to be transferred during the data transfer cycle. The bits decode as shown in Table 10.

Table 10. Byte Transfer Count

| N1 | N0 | Description          |
|----|----|----------------------|
| 0  | 0  | Transfer one byte    |
| 0  | 1  | Transfer two bytes   |
| 1  | 0  | Transfer three bytes |
| 1  | 1  | Transfer four bytes  |

Bits[4:0], A4, A3, A2, A1, and A0, determine which register is accessed during the data transfer of the communication cycle. For multibyte transfers, this address is a starting or ending address depending on the current data transfer mode. For MSB-first format, the specified address is an ending address or the most significant address in the current cycle. Remaining register addresses for multiple byte data transfers are generated internally by the serial port controller by decrementing from the specified address. For LSB-first format, the specified address is a beginning address or the least significant address in the current cycle. Remaining register addresses for multiple byte data transfers are generated internally by the serial port controller by incrementing from the specified address.

**MSB/LSB TRANSFERS**

The serial port can support both MSB-first and LSB-first data formats. This functionality is controlled by Register 0x00, Bit 6. The default is Logic 0, which is MSB-first format.

When using MSB-first format (LSBFIRST = 0), the instruction and data bit must be written from MSB to LSB. Multibyte data transfers in MSB-first format start with an instruction byte that includes the register address of the most significant data byte. Subsequent data bytes are loaded into sequentially lower address locations. In MSB-first mode, the serial port internal address generator decrements for each byte of the multibyte data transfer.

When using LSB-first format (LSBFIRST = 1), the instruction and data bit must be written from LSB to MSB. Multibyte data transfers in LSB-first format start with an instruction byte that includes the register address of the least significant data byte. Subsequent data bytes are loaded into sequentially higher address locations. In LSB-first mode, the serial port internal address generator increments for each byte of the multibyte data transfer.

Use of a single-byte transfer when changing the serial port data format is recommended to prevent unexpected device behavior.

**SERIAL INTERFACE PORT PIN DESCRIPTIONS**

**Chip Select Bar (CSB)**

Active low input starts and gates a communication cycle. It allows more than one device to be used on the same serial communication lines. CSB must stay low during the entire communication cycle. Incomplete data transfers are aborted anytime the CSB pin goes high. SDO and SDIO pins go to a high impedance state when this input is high.

**Serial Clock (SCLK)**

The serial clock pin is used to synchronize data to and from the device and to run the internal state machines. The maximum frequency of SCLK is 40 MHz. All data input is registered on the rising edge of SCLK. All data is driven out on the falling edge of SCLK.

**Serial Port Data I/O (SDIO)**

Data is always written into the device on this pin. However, SDIO can also function as a bidirectional data output line. The configuration of this pin is controlled by Register 0x00, Bit 7. The default is Logic 0, which configures the SDIO pin as unidirectional.

**Serial Port Data Output (SDO)**

Data is read from this pin for protocols that use separate lines for transmitting and receiving data. The configuration of this pin is controlled by Register 0x00, Bit 7. If this bit is set to a Logic 1, the SDO pin does not output data and is set to a high impedance state.

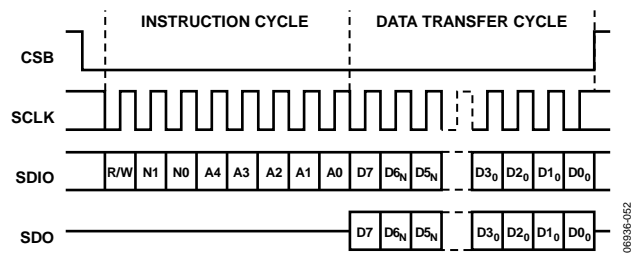


Figure 52. Serial Register Interface Timing Diagram, MSB First

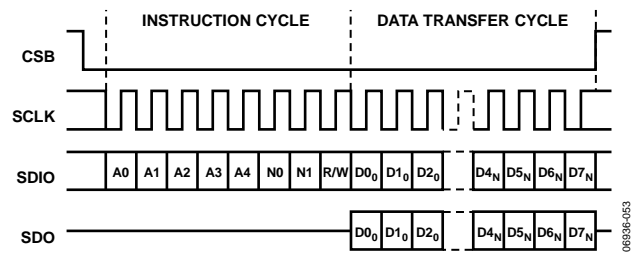


Figure 53. Serial Register Interface Timing Diagram, LSB First

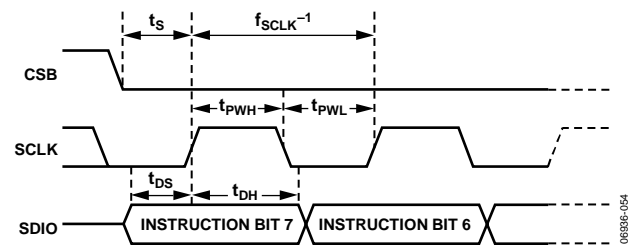


Figure 54. Timing Diagram for SPI Write Register

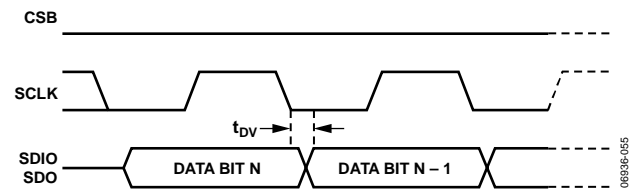


Figure 55. Timing Diagram for SPI Read Register

## SPI REGISTER MAP

Table 11.

| Register Name      | Addr | Default | Bit 7          | Bit 6    | Bit 5   | Bit 4         | Bit 3       | Bit 2        | Bit 1        | Bit 0   |
|--------------------|------|---------|----------------|----------|---------|---------------|-------------|--------------|--------------|---------|
| SPI Control        | 0x00 | 0x00    | SDIO_DIR       | LSBFIRST | RESET   |               |             |              |              |         |
| Data Control       | 0x02 | 0x00    | DATA           |          |         | INVDCO        |             |              |              |         |
| Power-Down         | 0x03 | 0x00    | PD_DCO         | PD_INPT  | PD_AUX2 | PD_AUX1       | PD_BIAS     | PD_CLK       | PD_DAC2      | PD_DAC1 |
| Setup and Hold     | 0x04 | 0x00    | SET[3:0]       |          |         |               | HLD[3:0]    |              |              |         |
| Timing Adjust      | 0x05 | 0x00    |                |          |         | SAMP_DLY[4:0] |             |              |              |         |
| Seek               | 0x06 | 0x00    |                |          |         |               | LVDS low    | LVDS high    | SEEK         |         |
| Mix Mode           | 0x0A | 0x00    |                |          |         | DAC1MIX[1:0]  |             | DAC2MIX[1:0] |              |         |
| DAC1 FSC           | 0x0B | 0xF9    | DAC1FSC[7:0]   |          |         |               |             |              |              |         |
| DAC1 FSC MSBs      | 0x0C | 0x01    |                |          |         |               |             |              | DAC1FSC[9:8] |         |
| AUXDAC1            | 0x0D | 0x00    | AUXDAC1[7:0]   |          |         |               |             |              |              |         |
| AUXDAC1 MSB        | 0x0E | 0x00    | AUX1SGN        | AUX1DIR  |         |               |             |              | AUXDAC1[9:8] |         |
| DAC2 FSC           | 0x0F | 0xF9    | DAC2FSC[7:0]   |          |         |               |             |              |              |         |
| DAC2 FSC MSBs      | 0x10 | 0x01    |                |          |         |               |             |              | DAC2FSC[9:8] |         |
| AUXDAC2            | 0x11 | 0x00    | AUXDAC2[7:0]   |          |         |               |             |              |              |         |
| AUXDAC2 MSB        | 0x12 | 0x00    | AUX2SGN        | AUX2DIR  |         |               |             |              | AUXDAC2[9:8] |         |
| BIST Control       | 0x1A | 0x00    | BISTEN         | BISTRD   | BISTCLR |               |             |              |              |         |
| BIST Result 1 Low  | 0x1B | 0x00    | BISTRES1[7:0]  |          |         |               |             |              |              |         |
| BIST Result 1 High | 0x1C | 0x00    | BISTRES1[15:8] |          |         |               |             |              |              |         |
| BIST Result 2 Low  | 0x1D | 0x00    | BISTRES2[7:0]  |          |         |               |             |              |              |         |
| BIST Result 2 High | 0x1E | 0x00    | BISTRES2[15:8] |          |         |               |             |              |              |         |
| Hardware Version   | 0x1F | N/A     | VERSION[3:0]   |          |         |               | DEVICE[3:0] |              |              |         |

## SPI REGISTER DESCRIPTIONS

Reading these registers returns previously written values for all defined register bits, unless otherwise noted.

Table 12.

| Register       | Address | Bit | Name          | Function  |
|----------------|---------|-----|---------------|---|
| SPI Control    | 0x00    | 7   | SDIO_DIR      | 0, operate SPI in 4-wire mode. The SDIO pin operates as an input only pin.<br>1, operate SPI in 3-wire mode. The SDIO pin operates as a bidirectional data line.  |
|                |         | 6   | LSBFIRST      | 0, MSB first per SPI standard.<br>1, LSB first per SPI standard.<br>Only change LSB/MSB order in single-byte instructions to avoid erratic behavior due to bit order errors.  |
|                |         | 5   | RESET         | 0, execute software reset of SPI and controllers, reload default register values except Register 0x00.<br>1, set software reset, write 0 on the next (or any following) cycle to release the reset.                                     |
| Data Control   | 0x02    | 7   | DATA          | 0, DAC input data is twos complement binary format.<br>1, DAC input data is unsigned binary format.   |
|                |         | 4   | INVDCO        | 1, inverts the data clock output. Used for adjusting timing of input data.  |
| Power-Down     | 0x03    | 7   | PD_DCO        | 1, power down data clock output driver circuit.   |
|                |         | 6   | PD_INPT       | 1, power down input.  |
|                |         | 5   | PD_AUX2       | 1, power down AUX2 DAC  |
|                |         | 4   | PD_AUX1       | 1, power down AUX1 DAC.   |
|                |         | 3   | PD_BIAS       | 1, power down voltage reference bias circuit.   |
|                |         | 2   | PD_CLK        | 1, power down DAC clock input circuit.  |
|                |         | 1   | PD_DAC2       | 1, power down DAC2.   |
|                |         | 0   | PD_DAC1       | 1, power down DAC1.   |
| Setup and Hold | 0x04    | 7:4 | SET[3:0]      | 4-bit value used to determine input data setup timing.  |
|                |         | 3:0 | HLD[3:0]      | 4-bit value used to determine input data hold timing.   |
| Timing Adjust  | 0x05    | 4:0 | SAMP_DLY[4:0] | 5-bit value used to optimally position input data relative to internal sampling clock.  |
| Seek           | 0x06    | 2   | LVDS low      | One of the LVDS inputs is above the input voltage limits of the IEEE reduced link specification.  |
|                |         | 1   | LVDS high     | One of the LVDS inputs is below the input voltage limits of the IEEE reduced link specification.  |
|                |         | 0   | SEEK          | Indicator bit used with LVDS_SET and LVDS HLD to determine input data timing margin.  |
| Mix Mode       | 0x0A    | 3:2 | DAC1MIX[1:0]  | 00, selects Normal Mode.<br>01, selects Mix Mode.<br>10, selects RZ Mode.<br>11, selects RZ Mode.   |
|                |         | 1:0 | DAC2MIX[1:0]  | 00, selects Normal Mode.<br>01, selects Mix Mode.<br>10, selects RZ Mode.<br>11, selects RZ Mode.   |
| DAC1 FSC       | 0x0B    | 7:0 | DAC1FSC[9:0]  | DAC1 full-scale 10-bit adjustment word.   |
|                | 0x0C    | 1:0 |               | 0x3FF, sets DAC full-scale output current to the maximum value of 31.66 mA.<br>0x200, sets DAC full-scale output current to the nominal value of 20.0 mA.<br>0x000, sets DAC full-scale output current to the minimum value of 8.66 mA. |

| Register         | Address      | Bit | Name           | Function   |
|------------------|--------------|-----|----------------|--|
| AUXDAC1          | 0x0D<br>0x0E | 7:0 | AUXDAC1[9:0]   | AUXDAC1 output current adjustment word.<br>0x3FF, sets AUXDAC1 output current to 2.0 mA.<br>0x200, sets AUXDAC1 output current to 1.0 mA.<br>0x000, sets AUXDAC1 output current to 0.0 mA.   |
|                  |              | 1:0 |                |  |
|                  | 0x0E         | 7   | AUX1SGN        | 0, AUX1P output pin is active.<br>1, AUX1N output pin is active.   |
|                  |              | 6   | AUX1DIR        | 0, configures AUXDAC1 output to source current.<br>1, configures AUXDAC1 output to sink current.   |
| DAC2 FSC         | 0x0F<br>0x10 | 7:0 | DAC2FSC[9:0]   | DAC2 full-scale 10-bit adjustment word.<br>0x3FF, sets DAC full-scale output current to the maximum value of 31.66 mA.<br>0x200, sets DAC full-scale output current to the nominal value of 20.0 mA.<br>0x000, sets DAC full-scale output current to the minimum value of 8.66 mA. |
|                  |              | 1:0 |                |  |
| AUXDAC2          | 0x11<br>0x12 | 7:0 | AUXDAC2[9:0]   | AUXDAC2 output current adjustment word.<br>0x3FF, sets AUXDAC2 output current to 2.0 mA.<br>0x200, sets AUXDAC2 output current to 1.0 mA.<br>0x000, sets AUXDAC2 output current to 0.0 mA.   |
|                  |              | 1:0 |                |  |
|                  | 0x12         | 7   | AUX2SGN        | 0, AUX2P output pin is active.<br>1, AUX2N output pin is active.   |
|                  |              | 6   | AUX2DIR        | 0, configures AUXDAC2 output to source current.<br>1, configures AUXDAC2 output to sink current.   |
| BIST Control     | 0x1A         | 7   | BISTEN         | 1, enables and starts built-in self-test.  |
|                  |              | 6   | BISTRD         | 1, transfers BIST result registers to SPI for readback.  |
|                  |              | 5   | BISTCLR        | 1, reset BIST logic and clear BIST result registers.   |
| BIST Result 1    | 0x1B<br>0x1C | 7:0 | BISTRES1[15:0] | 16-bit result generated by BIST 1.   |
|                  |              | 7:0 |                |  |
| BIST Result 2    | 0x1D<br>0x1E | 7:0 | BISTRES2[15:0] | 16-bit result generated by BIST 2.   |
|                  |              | 7:0 |                |  |
| Hardware Version | 0x1F         | 7:4 | VERSION[3:0]   | Read only register; indicates the version of the chip.   |
|                  |              | 3:0 | DEVICE[3:0]    | Read only register; indicates the device type.   |

### SPI PORT, RESET, AND PIN MODE

In general, when the AD9780/AD9781/AD9783 are powered up, an active high pulse applied to the RESET pin follows. This ensures the default state of all control register bits. In addition, once the RESET pin goes low, the SPI port can be activated; thus, CSB must be held high.

For applications without a controller, the AD9780/AD9781/AD9783 also supports pin mode operation, which allows some functional options to be pin selected without the use of the SPI port. Pin mode is enabled anytime the RESET pin is held high. In pin mode, the four SPI port pins take on secondary functions, as shown in Table 13.

Table 13. SPI Pin Functions (Pin Mode)

| Pin Name | Pin Mode Function  |
|----------|--|
| SDIO     | DATA (Register 0x02, Bit 7), bit value (1/0) equals pin state (high/low).                                |
| CSB      | Enable mix mode. If CSB is high, Register 0x0A is set to 0x05, putting both DAC1 and DAC2 into mix mode. |
| SDO      | Enable full power-down. If SDO is high, Register 0x03 is set to 0xFF.                                    |

## PARALLEL DATA PORT INTERFACE

The parallel port data interface consists of up to 18 differential signals, DCO, DCI, and up to 16 data lines (D[15:0]), as shown in Figure 56. DCO is the output clock generated by the AD9780/AD9781/AD9783 that is used to clock out the data from the digital data engine. The data lines transmit the multiplexed I and Q data words for the I and Q DACs, respectively. DCI provides timing information about the parallel data and signals the I/Q status of the data.

As diagrammed in Figure 56, the incoming LVDS data is latched by an internally generated clock referred to as the data sampling signal (DSS). DSS is a delayed version of the main DAC clock signal, CLKP/CLKN. Optimal positioning of the rising and falling edges of DSS with respect to the incoming data signals results in the most robust transmission of the DAC data. Positioning the edges of DSS with respect to the data signals is achieved by selecting the value of a programmable delay element, SMP. A procedure for determining the optimal value of SMP is given in the Optimizing the Parallel Port Timing section.

In addition to properly positioning the DSS edges, maximizing the opening of the eye in the clock input (DCIP/DCIN) and data signals improves the reliability of the data port interface. The two sources of degradation that reduce the eye in the clock input and data signals are the jitter on these signals and the skew between them. Therefore, it is recommended that the clock input signals be generated in the same manner as the data signals with the same output driver and data line routing. In other words, it must be implemented as a 17<sup>th</sup> data line with an alternating (010101 ...) bit sequence.

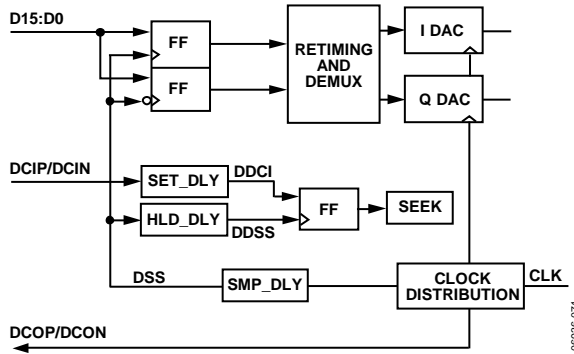


Figure 56. Digital Data Port Block Diagram

## OPTIMIZING THE PARALLEL PORT TIMING

Before outlining the procedure for determining the delay for SMP (that is, the positioning of DSS with respect to the data signals), it is worthwhile to describe the simplified block diagram of the digital data port. As can be seen in Figure 57, the data signals are sampled on the rising and falling edges of DSS. From there, the data is demultiplexed and retimed before being sent to the DACs.

The clock input signal provides timing information about the parallel data, as well as indicating the destination (that is, I DAC or Q DAC) of the data. A delayed version of DCI is generated by a delay element, SET, and is referred to as DDCI. DDCI is sampled by a delayed version of the DSS signal, labeled as DDSS in Figure 56. DDSS is simply DSS delayed by a period of time, HLD. The pair of delays, SET and HLD, allows accurate timing information to be extracted from the clock input. Increasing the delay of the HLD block results in the clock input being sampled later in its cycle. Increasing the delay of the SET block results in the clock input being sampled earlier in its cycle. The result of this sampling is stored and can be queried by reading the SEEK bit. Because DSS and the clock input signal are the same frequency, the SEEK bit must be a constant value. By varying the SET and HLD delay blocks and seeing the effect on the SEEK bit, the setup-and-hold timing of DSS with respect to clock input (and, hence, data) can be measured.

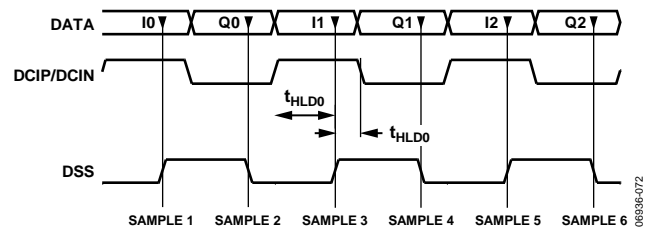


Figure 57. Timing Diagram of Parallel Interface

The incremental units of SET, HLD, and SMP are in units of real time, not fractions of a clock cycle. The nominal step size for SET and HLD is 80 ps. The nominal step size for SMP is 160 ps. Note that the value of SMP refers to Register 0x05, Bits[4:0], SET refers to Register 0x04, Bits[7:4], and HLD refers to Register 0x04, Bits[3:0].

A procedure for configuring the device to ensure valid sampling of the data signals follows. Generally speaking, the procedure begins by building an array of setup-and-hold values as the sample delay is swept through a range of values. Based on this information, a value of SMP is programmed to establish an optimal sampling point. This new sampling point is then double-checked to verify that it is optimally set.

### Building the Array

The following procedure is used to build the array:

1. Set the values of SMP, SET, and HLD to 0. Read and record the value of the SEEK bit.
2. With SMP and SET set to 0, increment the HLD value until the SEEK bit toggles, and then record the HLD value. This measures the hold time as shown in Figure 57.
3. With SMP and HLD set to 0, increment the SET value until the SEEK bit toggles, and then record the SET value. This measures the setup time as shown in Figure 57.
4. Set the value of SET and HLD to 0. Increment the value of SMP and record the value of the SEEK bit.
5. Increment HLD until the SEEK bit toggles, and then record the HLD value. Set HLD to 0 and increment SET until the SEEK bit toggles, and then record the SET value.
6. Repeat Step 4 and Step 5 until the procedure has been completed for SMP values from 0 to 31.

Note that while building the table, a value for either SET or HLD may not be found to make the SEEK bit toggle. In this case, assume a value of 15.

**Table 14. Timing Data Arrays**

| SMP | f <sub>DACLK</sub> = 200 MHz |     |     | f <sub>DACLK</sub> = 400 MHz |     |     | f <sub>DACLK</sub> = 500 MHz |     |     |
|-----|------------------------------|-----|-----|------------------------------|-----|-----|------------------------------|-----|-----|
|     | SEEK                         | SET | HLD | SEEK                         | SET | HLD | SEEK                         | SET | HLD |
| 0   | 0                            | 6   | 15  | 0                            | 2   | 13  | 0                            | 0   | 11  |
| 1   | 0                            | 8   | 15  | 0                            | 4   | 11  | 0                            | 2   | 9   |
| 2   | 0                            | 10  | 15  | 0                            | 6   | 9   | 0                            | 3   | 7   |
| 3   | 0                            | 12  | 15  | 0                            | 8   | 7   | 0                            | 5   | 5   |
| 4   | 0                            | 15  | 15  | 0                            | 10  | 4   | 0                            | 8   | 2   |
| 5   | 0                            | 15  | 13  | 0                            | 12  | 2   | 0                            | 10  | 1   |
| 6   | 0                            | 15  | 11  | 0                            | 14  | 1   | 1                            | 1   | 9   |
| 7   | 0                            | 15  | 9   | 1                            | 1   | 13  | 1                            | 2   | 7   |
| 8   | 0                            | 15  | 7   | 1                            | 3   | 11  | 1                            | 4   | 4   |
| 9   | 0                            | 15  | 5   | 1                            | 4   | 9   | 1                            | 7   | 2   |
| 10  | 0                            | 15  | 3   | 1                            | 6   | 7   | 1                            | 9   | 1   |
| 11  | 0                            | 15  | 1   | 1                            | 8   | 5   | 0                            | 1   | 10  |
| 12  | 0                            | 15  | 0   | 1                            | 10  | 3   | 0                            | 2   | 8   |
| 13  | 1                            | 1   | 15  | 1                            | 12  | 1   | 0                            | 4   | 7   |
| 14  | 1                            | 4   | 15  | 0                            | 0   | 15  | 0                            | 6   | 4   |
| 15  | 1                            | 6   | 15  | 0                            | 2   | 13  | 0                            | 9   | 2   |
| 16  | 1                            | 8   | 15  | 0                            | 4   | 11  | 0                            | 11  | 0   |
| 17  | 1                            | 10  | 15  | 0                            | 6   | 9   | 1                            | 1   | 8   |
| 18  | 1                            | 12  | 15  | 0                            | 7   | 7   | 1                            | 3   | 7   |
| 19  | 1                            | 13  | 15  | 0                            | 9   | 5   | 1                            | 5   | 5   |
| 20  | 1                            | 15  | 13  | 0                            | 11  | 3   | 1                            | 7   | 2   |
| 21  | 1                            | 15  | 11  | 0                            | 13  | 1   | 1                            | 9   | 1   |
| 22  | 1                            | 15  | 9   | 0                            | 15  | 0   | 0                            | 1   | 10  |
| 23  | 1                            | 15  | 7   | 1                            | 2   | 11  | 0                            | 2   | 8   |
| 24  | 1                            | 15  | 5   | 1                            | 4   | 9   | 0                            | 4   | 6   |
| 25  | 1                            | 15  | 3   | 1                            | 6   | 7   | 0                            | 7   | 4   |
| 26  | 1                            | 15  | 1   | 1                            | 8   | 5   | 0                            | 9   | 2   |
| 27  | 1                            | 15  | 0   | 1                            | 9   | 3   | 0                            | 10  | 0   |
| 28  | 0                            | 1   | 15  | 1                            | 11  | 2   | 1                            | 1   | 8   |
| 29  | 0                            | 1   | 15  | 1                            | 11  | 2   | 1                            | 1   | 8   |
| 30  | 0                            | 1   | 15  | 1                            | 11  | 2   | 1                            | 1   | 8   |
| 31  | 0                            | 1   | 15  | 1                            | 11  | 2   | 1                            | 1   | 8   |

Table 14 shows example arrays taken at DAC sample rates of 200 MHz, 400 MHz, and 500 MHz. It must be noted that the delay from the DCO input to the DCI output of the data source has a profound effect on when the SEEK bit toggles over the range of SMP values. Therefore, the tables generated in any particular system do not necessarily match the example timing data arrays in Table 14.

As may be seen in Table 14, at 500 MHz the device has only two working SMP settings. There is no way to monitor timing margin in real time, so the output must be interrupted to check or correct timing errors. The device must not be clocked above 500 MHz in applications where 100% up time is a requirement.

### Determining the SMP Value

Once the timing data array has been built, the value of SMP can be determined using the following procedure:

1. Look for the SMP value that corresponds to the 0-to-1 transition of the SEEK bit in the table. In the 500 MHz case from Table 14, this occurs for an SMP value of 6.
2. Look for the SMP value that corresponds to the 1-to-0 transition of the SEEK bit in the table. In the 500 MHz case from Table 14, this occurs for an SMP value of 11.
3. The same two values found in Step 1 and Step 2 indicate the valid sampling window. In the 500 MHz case, this occurs for an SMP value of 11.
4. The optimal SMP value in the valid sampling window is where the following two conditions are true: SET < HLD and |HLD – SET| is the smallest value.

In the 500 MHz case, the optimal SMP value is 7.

After programming the calculated value of SMP (referred to as SMP<sub>OPTIMAL</sub>), the configuration must be tested to verify that there is sufficient timing margin. This can be accomplished by ensuring that the SEEK bit reads back as a 1 for SMP values equal to SMP<sub>OPTIMAL</sub> + 1 and SMP<sub>OPTIMAL</sub> – 1. Also, it can be noted that the sum of SET and HLD must be a minimum of 8. If the sum is lower than this, you must check for excessive jitter on the clock input line and check that the frequency of the clock input does not exceed the data sheet maximum of 500 MHz (or 1000 Mbps).

As mentioned previously, low jitter and skew between the input data bits and DCI are critical for reliable operation at the maximum input data rates. Figure 58 shows the eye diagram for the input data signals that were used to collect the data in Table 14.

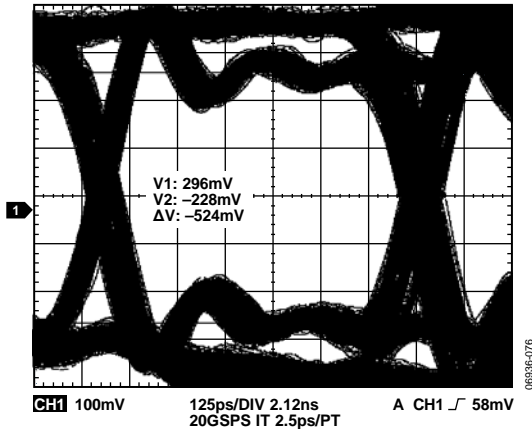


Figure 58. Eye Diagram of Data Source Used in Building the 500 MHz Timing Data Array of Table 14

Over temperature, the valid sampling window shifts. Therefore, when attempting operation of the device over 500 MHz, the timing must be optimized again whenever the device undergoes a temperature change of more than 20°C. Another consideration in the timing of the digital data port is the propagation delay variation from the clock output (DCOP/DCON) to the clock input. If this varies significantly over time (more than 25% of SET or HLD) due to temperature changes or other effects, repeat this timing calibration procedure.

At sample rates of  $\leq 400$  MSPS, the interface timing margin is sufficient to allow for a simplified procedure. In this case, the SEEK bit can be recorded as SMP is swept through the range from 0 to 31. The center of the first valid sampling window can then be chosen as the optimal value of SMP. Using the 400 MHz case from Table 14 as an example, the first valid sampling window occurs for SMP values of 7 to 13. The center of this window is 10, so 10 can be used as the optimal SMP value.

### BIST OPERATION

The BIST feature in the AD9780/AD9781/AD9783 is a simple type adder and is a user synchronizable BIST feature. In Register 0x1A, write 0x20 then 0x00 to clear the BIST registers while writing zeros to the data bits for at least eight clock cycles to propagate to the BIST signature module. Then enable BIST by writing 0x80 to Register 0x1A. Next, begin writing a known set of vectors to the data inputs. Proceed by writing zeros into the bits after the vectors while the BIST read is being performed. Perform a BIST read by writing 0xC0 to Register 0x1A to receive the unique sum of rising edge data in Register 0x1B and Register 0x1C and a unique sum of falling edge data in Register 0x1D and Register 0x1E. These register contents must always give the same values for the same vectors each time they are sent.

### DRIVING THE CLK INPUT

The CLK input requires a low jitter differential drive signal. It is a PMOS input differential pair powered from the 1.8 V supply; therefore, it is important to maintain the specified 400 mV input common-mode voltage. Each input pin can safely swing from 200 mV p-p to 1 V p-p about the 400 mV common-mode voltage. CLK can be driven by an offset ac-coupled signal, as shown in Figure 59.

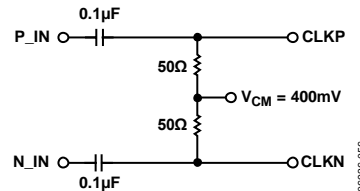


Figure 59. DAC CLK Drive Circuit

If a clean sine clock is available, it can be transformer-coupled to CLKP and CLKN as shown in Figure 60. Use of a CMOS or TTL clock is also acceptable for lower sample rates. It can then be ac-coupled, as described in this section. Alternatively, it can be transformer-coupled and clamped, as shown in Figure 60.

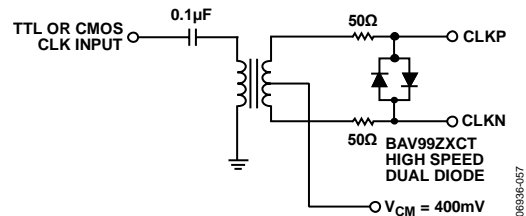


Figure 60. TTL or CMOS DAC CLK Drive Circuit

A simple bias network for generating the 400 mV common-mode voltage is shown in Figure 61. It is important to use CVDD18 and CGND for the clock bias circuit. Any noise or other signal coupled onto the clock is multiplied by the DAC digital input signal and can degrade the DAC's performance.

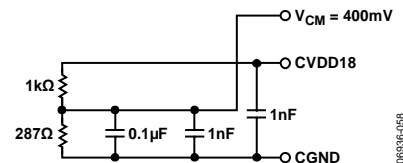


Figure 61. DAC CLK VCM Generator Circuit

## FULL-SCALE CURRENT GENERATION

### Internal Reference

Full-scale current on the I DAC and Q DAC can be set from 8.66 mA to 31.66 mA. Initially, the 1.2 V band gap reference is used to set up a current in an external resistor connected to FS ADJ (Pin 54). A simplified block diagram of the reference circuitry is shown in Figure 62. The recommended value for the external resistor is 10 kΩ, which sets up an  $I_{\text{REFERENCE}}$  in the resistor of 120 μA, which in turn provides a DAC output full-scale current of 20 mA. Because the gain error is a linear function of this resistor, a high precision resistor improves gain matching to the internal matching specification of the devices. Internal current mirrors provide a current-gain scaling, where I DAC or Q DAC gain is a 10-bit word in the SPI port register. The default value for the DAC gain registers gives a full-scale current output ( $I_{\text{FS}}$ ) of approximately 20 mA, where  $I_{\text{FS}}$  is equal to

$$I_{\text{FS}} = (86.6 + (0.220 \times \text{DAC gain})) \times 1000/R$$

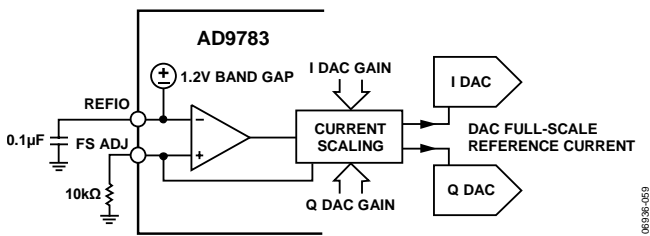


Figure 62. Reference Circuitry

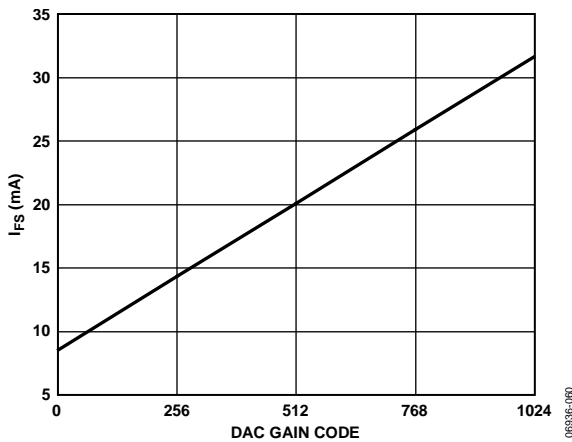


Figure 63.  $I_{\text{FS}}$  vs. DAC Gain Code

### DAC TRANSFER FUNCTION

Each DAC output of the AD9780/AD9781/AD9783 drives two complementary current outputs,  $I_{\text{OUTP}}$  and  $I_{\text{OUTN}}$ .  $I_{\text{OUTP}}$  provides a near  $I_{\text{FS}}$  when all bits are high. For example,

$$\text{DAC CODE} = 2^N - 1$$

where  $N = 12/14/16$  bits for AD9780/AD9781/AD9783 (respectively), while  $I_{\text{OUTN}}$  provides no current.

The current output appearing at  $I_{\text{OUTP}}$  and  $I_{\text{OUTN}}$  is a function of both the input code, and  $I_{\text{FS}}$  and can be expressed as

$$I_{\text{OUTP}} = (\text{DAC DATA}/2^N) \times I_{\text{FS}} \quad (1)$$

$$I_{\text{OUTN}} = ((2^N - 1) - \text{DAC DATA})/2^N \times I_{\text{FS}} \quad (2)$$

where  $\text{DAC DATA} = 0$  to  $2^N - 1$  (decimal representation).

The two current outputs typically drive a resistive load directly or via a transformer. If dc coupling is required,  $I_{\text{OUTP}}$  and  $I_{\text{OUTN}}$  must be connected to matching resistive loads ( $R_{\text{LOAD}}$ ) that are tied to analog common (AVSS). The single-ended voltage output appearing at the  $I_{\text{OUTP}}$  and  $I_{\text{OUTN}}$  pins is

$$V_{\text{OUTP}} = I_{\text{OUTP}} \times R_{\text{LOAD}} \quad (3)$$

$$V_{\text{OUTN}} = I_{\text{OUTN}} \times R_{\text{LOAD}} \quad (4)$$

Note that to achieve the maximum output compliance of 1 V at the nominal 20 mA output current,  $R_{\text{LOAD}}$  must be set to 50 Ω. Also note that the full-scale value of  $V_{\text{OUTP}}$  and  $V_{\text{OUTN}}$  must not exceed the specified output compliance range to maintain specified distortion and linearity performance.

There are two distinct advantages to operating the AD9780/AD9781/AD9783 differentially. First, differential operation helps cancel common-mode error sources associated with  $I_{\text{OUTP}}$  and  $I_{\text{OUTN}}$ , such as noise, distortion, and dc offsets. Second, the differential code-dependent current and subsequent output voltage ( $V_{\text{DIFF}}$ ) is twice the value of the single-ended voltage output ( $V_{\text{OUTP}}$  or  $V_{\text{OUTN}}$ ), providing  $2 \times$  signal power to the load.

$$V_{\text{DIFF}} = (I_{\text{OUTP}} - I_{\text{OUTN}}) \times R_{\text{LOAD}} \quad (5)$$

### ANALOG MODES OF OPERATION

The AD9780/AD9781/AD9783 use a proprietary quad-switch architecture that lowers the distortion of the DAC by eliminating a code-dependent glitch that occurs with conventional dual-switch architectures. This architecture eliminates the code-dependent glitches, but creates a constant glitch at a rate of  $2 \times f_{\text{DAC}}$ . For communications systems and other applications requiring good frequency domain performance from the DAC, this is seldom problematic.

The quad-switch architecture also supports two additional modes of operation: mix mode and return-to-zero mode. The waveforms of these two modes are shown in Figure 64. In mix mode, the output is inverted every other half clock cycle. This effectively chops the DAC output at the sample rate. This chopping has the effect of frequency shifting the sinc roll-off from dc to  $f_{\text{DAC}}$ . Additionally, there is a second subtle effect on the output spectrum. The shifted spectrum is also shaped by a second sinc function with a first null at  $2 \times f_{\text{DAC}}$ . The reason for this shaping is that the data is not continuously varying at twice the clock rate, but is simply repeated.

In return-to-zero mode, the output is set to midscale every other half clock cycle. The output is similar to the DAC output in normal mode except that the output pulses are half the width and half the area. Because the output pulses have half the width, the sinc function is scaled in frequency by two and has a first null at  $2 \times f_{DAC}$ . Because the area of the pulses is half that of the pulses in normal mode, the output power is half the normal mode output power.

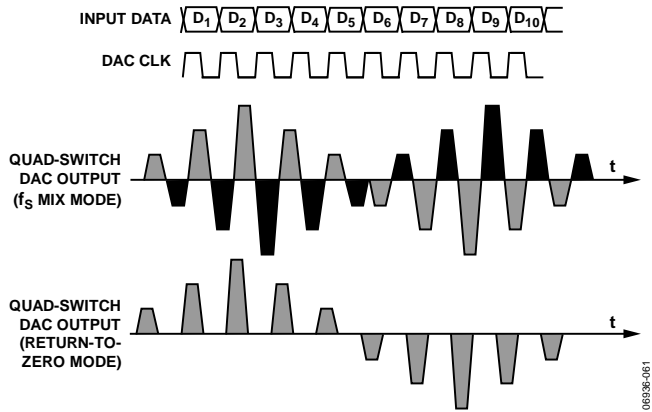


Figure 64. Mix Mode and Return-to-Zero Mode DAC Waveforms

The functions that shape the output spectrums for the three modes of operation, normal mode, mix mode, and return-to-zero mode, are shown in Figure 65. Switching between the analog modes reshapes the sinc roll-off inherent at the DAC output. This ability to change modes in the AD9780/AD9781/AD9783 makes the parts suitable for direct IF applications. The user can place a carrier anywhere in the first three Nyquist zones depending on the operating mode selected. The performance and maximum amplitude in all three Nyquist zones is impacted by this sinc roll-off depending on where the carrier is placed, as shown in Figure 65.

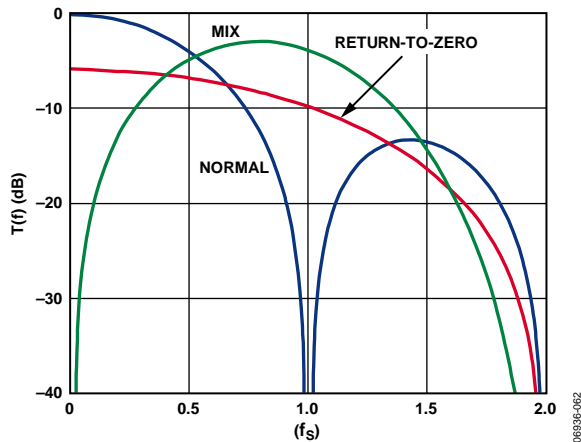


Figure 65. Transfer Function for Each Analog Operating Mode

**Auxiliary DACs**

Two auxiliary DACs are provided on the AD9780/AD9781/AD9783. A functional diagram is shown in Figure 66. The auxiliary DACs are current output devices with two output pins, AUXP and AUXN. The active pin can be programmed to either source or sink current. When either sinking or sourcing, the full-scale current magnitude is 2 mA. The available compliance range at the auxiliary DAC outputs depends on whether the output is configured to sink or source current. When sourcing current, the compliance voltage is 0 V to 1.6 V, but when sinking current, the output compliance voltage is reduced to 0.8 V to 1.6 V. Either output can be used, but only one output of the AUX DAC (P or N) is active at any time. The inactive pin is always in a high impedance state ( $>100 \text{ k}\Omega$ ).

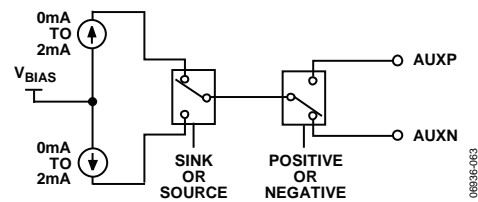


Figure 66. Auxiliary DAC Functional Diagram

In a single sideband transmitter application, the combination of the input referred dc offset voltage of the quadrature modulator and the DAC output offset voltage can result in local oscillator (LO) feedthrough at the modulator output, which degrades system performance. The auxiliary DACs can be used to remove the dc offset and the resulting LO feedthrough. The circuit configuration for using the auxiliary DACs for performing dc offset correction depends on the details of the DAC and modulator interface. An example of a dc-coupled configuration with low-pass filtering is shown in Figure 67.

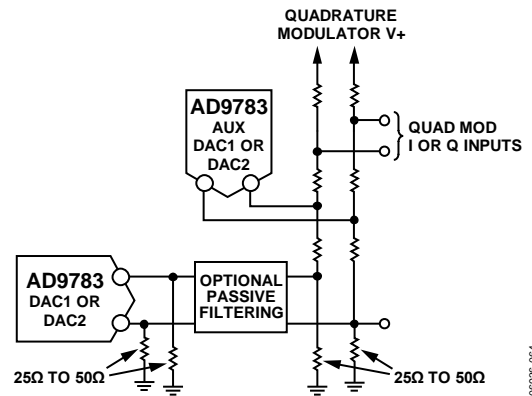


Figure 67. DAC DC-Coupled to Quadrature Modulator with a Passive DC Shift

**POWER DISSIPATION**

Figure 68 through Figure 73 show the power dissipation of the part in single DAC and dual DAC modes.

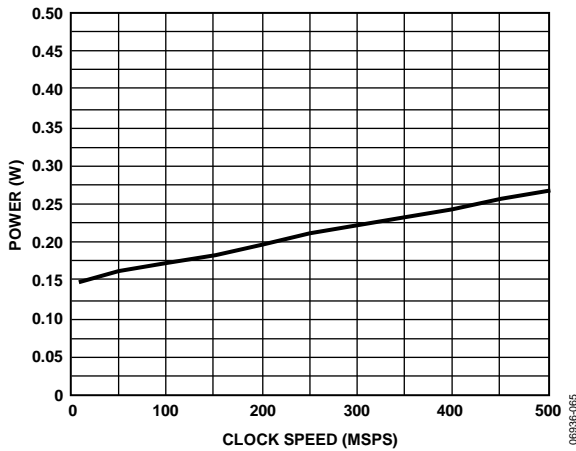


Figure 68. Power Dissipation, I Data Only, Single DAC Mode

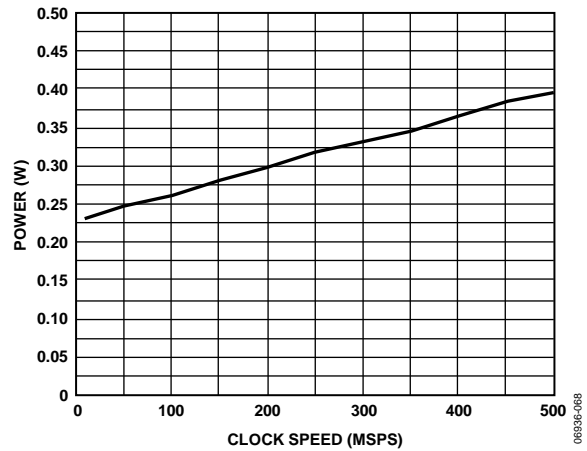


Figure 71. Power Dissipation, I and Q Data, Dual DAC Mode

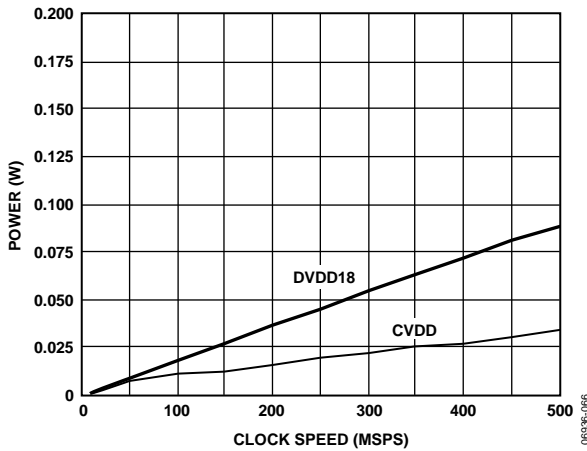


Figure 69. Power Dissipation, Digital 1.8 V Supply, Clock 1.8 V Supply, I Data Only

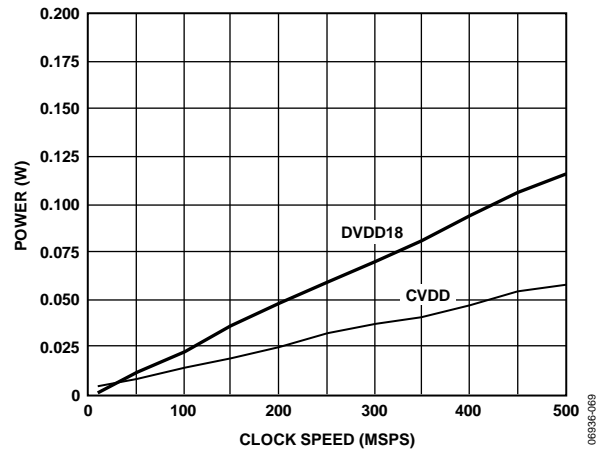


Figure 72. Power Dissipation, Digital 1.8 V Supply, Clock 1.8 V Supply, I and Q Data, Dual DAC Mode

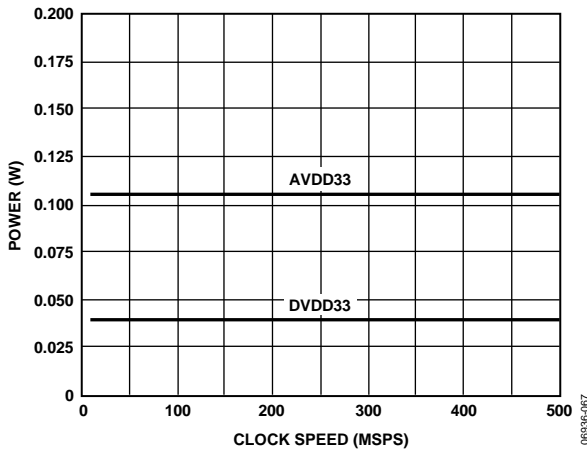


Figure 70. Power Dissipation, Digital 3.3 V Supply, Analog 3.3 V Supply, I Data Only

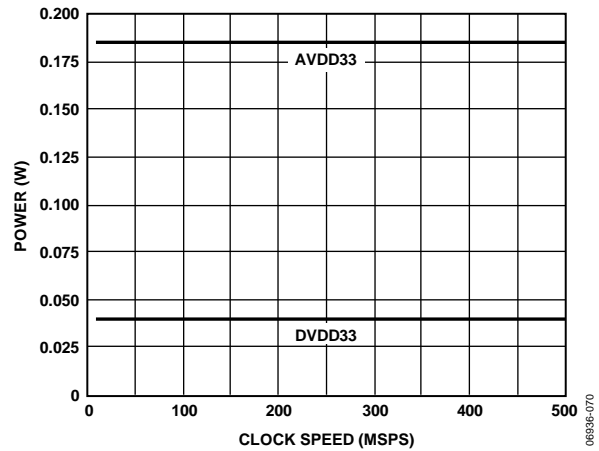
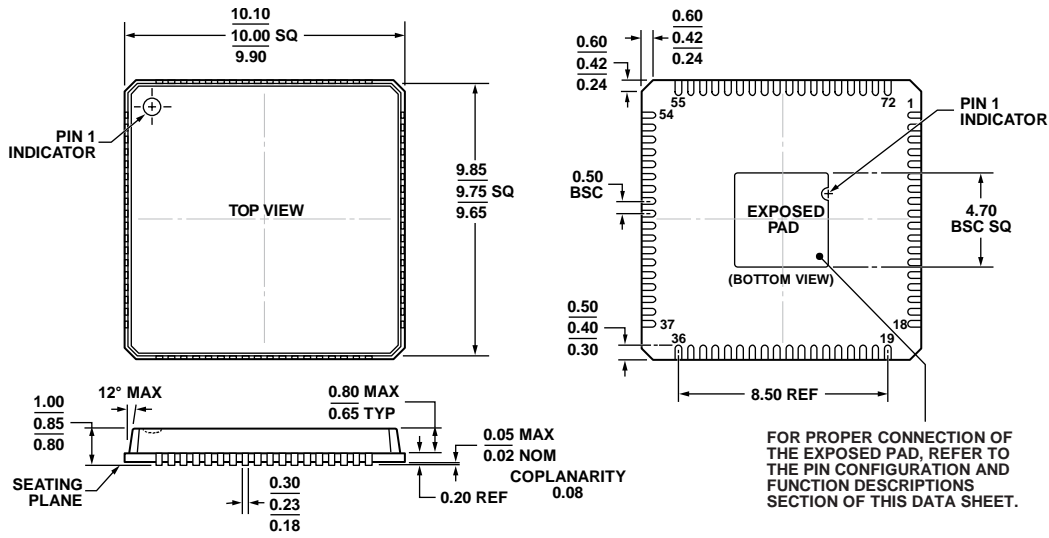


Figure 73. Power Dissipation, Digital 3.3 V Supply, Analog 3.3 V Supply, I and Q Data, Dual DAC Mode

### OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-VNND-4

Figure 74. 72-Lead Lead Frame Chip Scale Package [LFCSP\_VQ]  
 10 mm × 10 mm, Very Thin Quad  
 (CP-72-1)  
 Dimensions shown in millimeters

06-07-2012-A

### ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description | Package Option |
|--------------------|-------------------|---------------------|----------------|
| AD9780BCPZ         | -40°C to +85°C    | 72-Lead LFCSP_VQ    | CP-72-1        |
| AD9780BCPZRL       | -40°C to +85°C    | 72-Lead LFCSP_VQ    | CP-72-1        |
| AD9781BCPZ         | -40°C to +85°C    | 72-Lead LFCSP_VQ    | CP-72-1        |
| AD9781BCPZRL       | -40°C to +85°C    | 72-Lead LFCSP_VQ    | CP-72-1        |
| AD9783BCPZ         | -40°C to +85°C    | 72-Lead LFCSP_VQ    | CP-72-1        |
| AD9783BCPZRL       | -40°C to +85°C    | 72-Lead LFCSP_VQ    | CP-72-1        |
| AD9783-DPG2-EBZ    |                   | Evaluation Board    |                |

<sup>1</sup> Z = RoHS Compliant Part.

**NOTES**

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